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### LM49450

**Boomer**® Audio Power Amplifier Series

# I<sup>2</sup>S Input, 2.5W/Channel, Low EMI, Stereo, Class D Audio Sub-System with Ground Referenced Headphone Amplifier, 3D Enhancement, and Headphone Sense

#### **General Description**

The LM49450 is a fully integrated audio subsystem designed for portable media player applications. The LM49450 combines a 24-bit I<sup>2</sup>S digital-to-analog converter (DAC), 2.5W/ channel stereo Class D speaker drivers, 36mW stereo ground referenced headphone drivers, volume control, and National's unique 3D sound enhancement into a single device.

The filterless Class D amplifiers deliver 1.25W/channel into an  $8\Omega$  load with <1% THD+N with a 5V supply. The LM49450 offers two logic selectable modulation schemes, fixed frequency mode, and an EMI reducing spread spectrum mode. The 36mW/channel headphone drivers feature National's ground referenced architecture that creates a ground-referenced output from a single supply, eliminating the need for bulky and expensive DC-blocking capacitors, saving space and minimizing system cost. A headphone sense input (HPS) automatically detects the presence of a headphone, and configures the device accordingly.

The LM49450 stereo, 24-bit DAC supports a wide range of sample rates (including 192kHz, 96kHz, 48kHz, and 44.1kHz). The digital audio signal path features better than 100dB SNR, and low 0.05% THD+N when measured at the headphone outputs. The flexible 3-wire I<sup>2</sup>S interface supports left or right justified audio data.

The LM49450 features separate 32-step volume control for the headphones and speaker outputs. 3D enhancement, mode selection, shutdown control, and volume are controlled through an I<sup>2</sup>C compatible interface.

Output short circuit and thermal overload protection prevent the device from being damaged during fault conditions. Superior click and pop suppression eliminates audible transients on power-up/down and during shutdown. The LM49450 is available in a space saving 32-pin LLP package.

### **Key Specifications**

|   | SNR at Headphone Output | 102dBA (typ) |
|---|-------------------------|--------------|
| _ | 0 1 4 10 50             |              |

- Speaker Amplifier Efficiency at 3.6V, 650mW/channel into 8Ω
   87% (typ)
- Speaker Amplifier Efficiency at 5V, 1.1W/channel into  $8\Omega$  80% (typ)
- Quiescent Power Supply Current Line Inputs:

| Speaker Mode at LSV <sub>DD</sub> = 3.6V   | 7.5mA (typ) |
|--|-------------|
| Headphone Mode at HPV <sub>DD</sub> = 2.5V | 5.3mA (typ) |

■ Output Power/Channel

Speaker at LSV<sub>DD</sub> = 5V:

 $R_L = 4\Omega$ , THD+N  $\leq 10\%$  2.5W (typ)

August 4, 2011

 $R_L = 8\Omega$ , THD+N  $\leq 1\%$  1.25W (typ)

Headphone at  $HPV_{DD} = 2.5V$ :

 $R_L = 16\Omega$ , THD+N  $\leq 1\%$  34mW (typ)

 $R_L = 32\Omega$ , THD+N  $\leq 1\%$  36mW (typ)

■ PSRR at 1kHz
Speaker Mode
Headphone Mode

For Street St

■ Shutdown current 0.02µA (typ)

#### **Features**

- 24-Bit Stereo DAC
- Stereo Filterless Class D Operation
- Selectable spread spectrum mode reduces EMI
- Ground Referenced Headphone Amplifiers with 100dB SNR
- I<sup>2</sup>S Compatible Audio Interface
- Audio Sample Rates up to 192kHz
- National's 3D Enhancement
- 32-step Digital Volume Control
- I2C Compatible Control Interface
- Headphone Sense Input
- Stereo Analog Line Inputs
- Output Short Circuit Protection
- Thermal Overload Protection
- Minimum external components
- Click and Pop suppression
- Micro-power shutdown
- Available in space-saving 32 pin LLP package

#### **Applications**

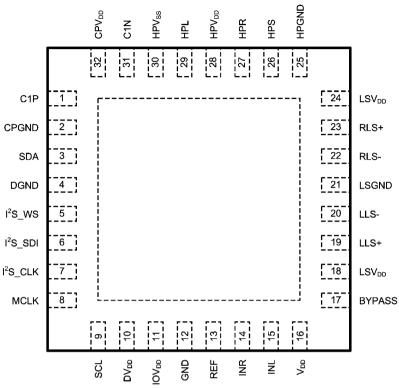
- Portable Media Players
- Portable Navigation Devices
- Multi-Media Monitors
- Laptops
- Portable Gaming Devices
- Mobile Handsets

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## **Typical Application** HPV<sub>DD</sub> HPGND HPV<sub>DD</sub> HPR Η CLASS D FIGURE 1. Typical Audio Amplifier Application Circuit 32-STEP VOLUME CONTROL CPGND HPVSS CHARGE PUMP OSCILLATOR C1P V<sub>DD</sub> 2.7V to 5.5V LSV<sub>DD</sub> C1N 24-BIT STEREO DAC Vpp || |-CPVDD CPV<sub>DD</sub> 3D PROCESSOR DGND ⊣ŀ I<sup>2</sup>C INTERFACE 1<sup>2</sup>S Interface IOV<sub>DD</sub> GND CREF CREF MCLK I2S\_CLK INR BYPASS I2S\_SDI I2S\_WS ₹ SCL I2C BUS

### **Connection Diagrams**

#### SQ Package 5mm x 5mm x 0.8mm



300455a7

Top View Order Number LM49450SQ See NS Package Number SQA32A

> SQ Marking 5mm x 5mm x 0.8mm

NS UZXYTT L49450

30045533

Top View
NS - NS Logo
U - Wafer Fab Code
Z - Assembly Plant
XY - 2 Digit Date Code
TT - Lot Traceability
L49450 - LM49450SQ

#### **Absolute Maximum Ratings** (Note 1, Note

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (Note 1) 6.0V Storage Temperature -65°C to +150°C Input Voltage -0.3V to  $V_{DD} + 0.3V$ Power Dissipation (Note 3) Internally Limited ESD Susceptibility(Note 4) 2000V ESD Susceptibility (Note 5) 200V Junction Temperature (T,IMAX) 150°C Thermal Resistance

2.4°C/W  $\theta_{JC}$ 28.4°C/W  $\theta_{JA}$ 

### Operating Ratings (Note 1, Note 2)

Temperature Range

 $T_{MIN} \le T_A \le T_{MAX}$  $-40^{\circ}\text{C} \le \text{T}_{A} \le +85^{\circ}\text{C}$ Supply Voltage  $2.7 \mathsf{V} \le \mathsf{V}_\mathsf{DD} \le 5.5 \mathsf{V}$  $(V_{DD}, LSV_{DD})$ 

Headphone Supply Voltage

 $(CPV_{DD}, HPV_{DD})$ 

Digital Core Supply Voltage

 $2.7V \le DV_{DD} \le 4.5V$  $(DV_{DD})$ 

Digital IO Supply Voltage (IOV<sub>DD</sub>)

 $1.8V \le IOV_{DD} \le 4.5V$ 

 $1.8V \le V_{DD} \le 2.7V$ 

otherwise specified. Limits apply for  $T_A = 25$ °C.

|                   |                                |  | LM4          | I I mile m |                      |  |  |  |  |
|-------------------|--------------------------------|--|--------------|------------|----------------------|--|--|--|--|
| Symbol            | Parameter                      | Conditions   | Typical      | Limit      | Units                |  |  |  |  |
|                   |                                |  | (Note 6)     | (Note 7)   | (Limits)             |  |  |  |  |
| DI <sub>DD</sub>  | Digital Core Supply Current    | $DV_{DD} = 2.7V, f_S = 48kHz,$<br>$f_{MCLK} = 12.28MHz$                    | 9            | 11.2       | mA (max)             |  |  |  |  |
| I <sub>SD</sub>   | Shutdown Supply Current        | Digital Current Analog Current   | 0.03<br>0.02 | 1          | μΑ (max)<br>μΑ (max) |  |  |  |  |
| SPEAKER AM        | IPLIFIERS (Headphone Amplifier | s Disabled, HPS = 0)   |              | !          |                      |  |  |  |  |
| I <sub>DDLS</sub> | Analog Supply Current          | f <sub>S</sub> = 48kHz, DAC Active, No Load<br>Line Inputs Active, No Load | 9.8<br>7     | 13<br>10   | mA (max)<br>mA (max) |  |  |  |  |
| V <sub>OS</sub>   | Output Offset Voltage          | DAC Active<br>Line Inputs Active   | 8<br>8       | 45         | mV (max)<br>mV (max) |  |  |  |  |
| P <sub>out</sub>  | Output Power                   | $R_L = 4\Omega$ , $f = 1$ kHz<br>THD+N = 1%<br>THD+N = 10%                 | 1<br>1.2     |            | W<br>W               |  |  |  |  |
| . 001             | Саграст опо                    | $R_L = 8\Omega$ , $f = 1kHz$<br>THD+N = 1%<br>THD+N = 10%                  | 625<br>725   | 525        | mW (min)<br>W        |  |  |  |  |
|                   |                                | $P_O = 300$ mW, $f = 1$ kHz, $R_L = 8\Omega$                               |              |            |                      |  |  |  |  |
| THD+N             | Total Harmonic Distortion      | DAC Active   | 0.06         |            | %                    |  |  |  |  |
|                   |                                | Line Inputs Active   | 0.07         |            | %                    |  |  |  |  |
|                   |                                | V <sub>RIPPLE</sub> = 200mV <sub>P-P</sub> , f = 1kHz                      |              |            |                      |  |  |  |  |
| PSRR              | Dower Cumply Dejection Datio   | DAC Active, Internal Reference   | 59           | 45         | dB (min)             |  |  |  |  |
| PORR              | Power Supply Rejection Ratio   | DAC Active, External Reference   | 62           |            | dB                   |  |  |  |  |
|                   |                                | Line Inputs Active   | 67           |            | dB                   |  |  |  |  |
| η                 | Efficiency                     | $P_O = 650$ , $f = 1$ kHz<br>$R_L = 8\Omega$                               | 87           |            | %                    |  |  |  |  |
|                   |                                | $P_O = 500$ mW, $f = 1$ kHz, $R_L = 8\Omega$                               |              |            |                      |  |  |  |  |
| V+all.            | Crosstelle                     | DAC Active,<br>Line Inputs Active  | 81<br>77     |            | dB<br>dB             |  |  |  |  |
| Xtalk             | Crosstalk                      | $P_0 = 500 \text{mW}, f = 10 \text{kHz}, R_L = 8\Omega$                    |              |            | •                    |  |  |  |  |
|                   |                                | DAC Active,<br>Line Inputs Active  | 60<br>60     |            | dB<br>dB             |  |  |  |  |

| Symbol              |                                 |  | LM4      | Units      |                     |
|---------------------|---------------------------------|--|----------|------------|---------------------|
|                     | Parameter                       | Conditions   | Typical  | Limit      | (Limits)            |
|                     |                                 |  | (Note 6) | (Note 7)   | (2)                 |
|                     |                                 | P <sub>O</sub> = 500mW, f = 1kHz, A-weighted         |          |            |                     |
| SNR                 | Signal to Noise Ratio           | DAC Active, Internal Reference                       | 89       |            | dB                  |
| JIVIT               | Signal to Noise Hallo           | DAC Active, External Reference                       | 92       |            | dB                  |
|                     |                                 | Line Inputs Active                                   | 90       |            | dB                  |
|                     |                                 | Maximum Gain Setting, Line Inputs                    | 23.6     | 22.5       | dB (min)            |
| $A_V$               | Digitally Controlled Gain Level | Active   | 20.0     | 24.1       | dB (max             |
| V                   |                                 | Minimum Gain Setting, Line Inputs Active             | -48      | -49<br>-46 | dB (min)<br>dB (max |
| Mute                | Mute Attenuation                | Line Inputs Active                                   | -91      |            | dB                  |
| Λ Λ                 | Channel-to-Channel Gain         |  | 0.3      |            | dB                  |
| ΔA <sub>CH-CH</sub> | Matching                        |  | 0.3      |            | uБ                  |
|                     |                                 | Input Referred, A-weighted                           |          |            |                     |
|                     | Output Naisa                    | DAC Active, Internal Reference                       | 43.5     |            | μV                  |
| os                  | Output Noise                    | DAC Active, External Reference                       | 45.4     |            | μV                  |
|                     |                                 | Line Inputs Active                                   | 40       |            | μV                  |
| ON                  | Turn-On Time                    |  | 27       |            | ms                  |
| OFF                 | Turn-Off Time                   |  | 1        |            | ms                  |
|                     | AMPLIFIERS (Speaker Amplifiers  | S Disabled, HPS = 1)                                 |          | l.         | -                   |
|                     |                                 | f <sub>S</sub> = 48kHz, DAC active                   | 7.2      | 8.25       | mA (max             |
| I <sub>DDHP</sub>   | Analog Supply Current           | Line Inputs Active                                   | 5.3      | 6.5        | mA (max             |
|                     | 2 2                             | DAC active, $A_V = -6dB$                             | 7        |            | mV                  |
| V <sub>os</sub>     | Output Offset Voltage           | Line Inputs Active, , $A_V = -6dB$                   | 5        | 30         | mV (max             |
|                     |                                 | $R_L = 16\Omega$ , $f = 1kHz$                        |          | !          |                     |
|                     |                                 | THD+N = 1%, Single Channel                           | 66       |            | mW                  |
|                     |                                 | THD+N = 1%, Two Channels in                          |          |            |                     |
| _                   |                                 | Phase  | 34       |            | mW                  |
| Po                  | Output Power                    | $R_L = 32\Omega$ , $f = 1kHz$                        |          | •          | <u>'</u>            |
|                     |                                 | THD+N = 1%, Single Channel                           | 49       | 42         | mW (min             |
|                     |                                 | THD+N = 1%, Two Channels in                          |          |            |                     |
|                     |                                 | Phase  | 36       | 27         | mW (min             |
|                     |                                 | f = 1kHz, DAC Active                                 |          | •          | '                   |
| THD+N               | Total Harmonic Distortion       | $R_L = 16\Omega$ , $P_O = 5$ mW                      | 0.05     |            | %                   |
|                     |                                 | $R_L = 32\Omega$ , $P_O = 5$ mW                      | 0.03     |            | %                   |
|                     |                                 | $V_{RIPPLE} = 200 \text{mV}_{P-P}, f = 1 \text{kHz}$ |          | l          |                     |
|                     |                                 | DAC Active, Internal Reference                       | 71.2     | 56         | dB (min)            |
| PSRR                | Power Supply Rejection Ratio    | DAC Active, External Reference                       | 71.3     | 00         | dB (IIIII)          |
|                     |                                 | Line Inputs Active                                   | 76.9     |            | dB                  |
|                     |                                 | $P_O = 5$ mW, $f = 1$ kHz, $R_L = 32\Omega$          | 7 0.0    | ļ.         |                     |
|                     |                                 | DAC Active.  | 82       |            | dB                  |
|                     |                                 | Line Inputs Active                                   | 79       |            | dB                  |
| Xtalk               | Crosstalk                       | $P_O = 5$ mW, $f = 10$ kHz, $R_L = 32\Omega$         |          | I .        | 1 35                |
|                     |                                 | DAC Active,  | 78       |            | dB                  |
|                     |                                 | Line Inputs Active                                   | 76<br>76 |            | dB                  |
|                     |                                 | $P_O = 5$ mW, $f = 1$ kHz, A-weighted                |          | ļ          | 1 45                |
|                     |                                 | DAC Active, Internal Reference                       | 99       |            | dB                  |
| SNR                 | Signal to Noise Ratio           | DAC Active, Internal Reference                       | 102      |            | dB<br>dB            |
|                     | 1                               | DAO AGIVO, EXIGINAL NEIGIGIDE                        | 102      | ļ          | UD.                 |

|                     |  |  | LM <sup>2</sup> |              |                         |  |
|---------------------|--|--|-----------------|--------------|-------------------------|--|
| Symbol              | Parameter  | Conditions                               | Typical         | Limit        | Units                   |  |
|                     |  |  | (Note 6)        | (Note 7)     | (Limits)                |  |
| Δ.                  | Distribute Controlled Coin Loyal                 | Maximum Gain Setting, Line Inputs Active | 17.8            | 17.0<br>18.5 | dB (min)<br>dB (max)    |  |
| A <sub>V</sub>      | Digitally Controlled Gain Level                  | Minimum Gain Setting, Line Inputs Active | -53.8           | -56<br>-52   | dB (min)<br>dB (max)    |  |
| Mute                | Mute Attenuation                                 | Line Inputs Active                       | -102            |              | dB                      |  |
| ΔA <sub>CH-CH</sub> | Channel-to-Channel Gain<br>Matching              |  | 0.3             |              | dB                      |  |
|                     |  | Input Referred, A-weighted               |                 | •            |                         |  |
|                     | Output Noise                                     | DAC Active, Internal Reference           | 10              |              | μV                      |  |
| ε <sub>OS</sub>     |  | DAC Active, External Reference           | 10              |              | μV                      |  |
|                     |  | Line Inputs Active                       | 10              |              | μV                      |  |
| V <sub>OUT_FS</sub> | Full-Scale Headphone Amplifier<br>Output Voltage | R <sub>L</sub> = No Load                 | 942             | 850          | mV <sub>RMS</sub> (min) |  |
| t <sub>ON</sub>     | Turn-On Time                                     |  | 27              |              | ms                      |  |
| t <sub>OFF</sub>    | Turn-Off Time                                    |  | 1               |              | ms                      |  |
| HEADPHONE           | SENSE INPUT (HPS)                                |  |                 | •            | •                       |  |
| V <sub>IH</sub>     | Input High Voltage                               |  | 1               |              | V                       |  |
| V <sub>IL</sub>     | Input Low Voltage                                |  | 0.6             |              | V                       |  |
| DIGITAL INTE        | RFACE  |  |                 |              |                         |  |
| V <sub>IH</sub>     | Input High Voltage                               |  |                 | 2.8          | V (min)                 |  |
| V <sub>IL</sub>     | Input Low Voltage                                |  |                 | 0.8          | V (max)                 |  |
| V <sub>OH</sub>     | Output High Voltage                              |  |                 | 2            | V (min)                 |  |
| V <sub>OL</sub>     | Output Low Voltage                               |  |                 | 1            | V (max)                 |  |

|                   |                                 |  | LM4      |          |          |  |
|-------------------|---------------------------------|--|----------|----------|----------|--|
| Symbol            | Parameter                       | Conditions   | Typical  | Limit    | Units    |  |
|                   |                                 |  | (Note 6) | (Note 7) | (Limits) |  |
| SPEAKER AN        | MPLIFIERS (Headphone Amplifiers | s Disabled, HPS = 0)                                       |          |          | •        |  |
|                   | Analog Cupply Current           | f <sub>S</sub> = 48kHz, DAC Active                         | 14       | 18       | mA (max) |  |
| I <sub>DDLS</sub> | Analog Supply Current           | Line Inputs Active   | 10.4     | 16       | mA (max) |  |
|                   | Output Offset Voltage           | DAC Voltage  | 15       | 50       | mV (max) |  |
| V <sub>os</sub>   | Output Offset Voltage           | AV = 0dB, Line Inputs Active                               | 12       | 48       | mV (max) |  |
|                   |                                 | $R_L = 4\Omega$ , $f = 1kHz$                               |          |          |          |  |
|                   | Output Power                    | THD+N = 1%   | 1.9      |          | W        |  |
| D                 |                                 | THD+N = 10%  | 2.5      |          | W        |  |
| P <sub>OUT</sub>  |                                 | $R_L = 8\Omega$ , $f = 1kHz$                               |          |          |          |  |
|                   |                                 | THD+N = 1%   | 1.25     |          | mW (min) |  |
|                   |                                 | THD+N = 10%  | 1.54     |          | W        |  |
|                   |                                 | $P_{O} = 635 \text{mW}, f = 1 \text{kHz}, R_{L} = 8\Omega$ |          | -        | -        |  |
| THD+N             | Total Harmonic Distortion       | DAC Active   | 0.06     |          | %        |  |
|                   |                                 | Line Inputs Active   | 0.04     |          | %        |  |
|                   |                                 | $V_{RIPPLE} = 200 \text{mV}_{P-P}, f = 1 \text{kHz}$       |          |          | •        |  |
| PSRR              | Power Supply Rejection Patio    | DAC Active, Internal Reference                             | 60       |          | dB       |  |
| ronn              | Power Supply Rejection Ratio    | DAC Active, External Reference                             | 60       |          | dB       |  |
|                   |                                 | Line Inputs Active   | 70       |          | dB       |  |

|                     |                                     |   | LM4      |              |                      |  |  |  |  |
|---------------------|-------------------------------------|---|----------|--------------|----------------------|--|--|--|--|
| Symbol              | Parameter                           | Conditions  | Typical  | Limit        | Units                |  |  |  |  |
|                     |                                     |   | (Note 6) | (Note 7)     | (Limits)             |  |  |  |  |
| η                   | Efficiency                          | $P_O = TBDmW, f = 1kHz$<br>$R_L = 8\Omega$                  | 80       |              | %                    |  |  |  |  |
|                     |                                     | $P_O = 500$ mW, $f = 1$ kHz, $R_L = 8\Omega$                |          | •            |                      |  |  |  |  |
|                     |                                     | DAC Active,<br>Line Inputs Active                           | 74<br>79 |              | dB<br>dB             |  |  |  |  |
| Xtalk               | Crosstalk                           | $P_{O} = 500 \text{mW}, f = 10 \text{kHz}, R_{L} = 8\Omega$ |          |              |                      |  |  |  |  |
|                     |                                     | DAC Active,<br>Line Inputs Active                           | 60<br>60 |              | dB<br>dB             |  |  |  |  |
|                     |                                     | P <sub>O</sub> = 500mW, f = 1kHz, A-weighted                |          |              |                      |  |  |  |  |
| SNR                 | Signal to Noise Ratio               | DAC Active, Internal Reference                              | 88       |              | dB                   |  |  |  |  |
| SIND                |                                     | DAC Active, External Reference                              | 89       |              | dB                   |  |  |  |  |
|                     |                                     | Line Inputs Active  | 98       |              | dB                   |  |  |  |  |
| ۸                   | Dimitally Combustled Coin Loyel     | Maximum Gain Setting, Line Inputs Active                    | 24.2     | 22.5<br>24.2 | dB (min)<br>dB (max) |  |  |  |  |
| A <sub>V</sub>      | Digitally Controlled Gain Level     | Minimum Gain Setting, Line Inputs Active                    | -48      | -49<br>-46   | dB (min)<br>dB (max) |  |  |  |  |
| Mute                | Mute Attenuation                    | Line Inputs Active  | -92      |              | dB                   |  |  |  |  |
| ΔA <sub>CH-CH</sub> | Channel-to-Channel Gain<br>Matching |   | 0.3      |              | dB                   |  |  |  |  |
|                     |                                     | Input Referred, A-weighted                                  |          |              |                      |  |  |  |  |
|                     |                                     | DAC Active, Internal Reference                              | 60       |              | μV                   |  |  |  |  |
| ε <sub>OS</sub>     | Output Noise                        | DAC Active, External Reference                              | 85       |              | μV                   |  |  |  |  |
|                     |                                     | Line Inputs Active  | 40       |              | μV                   |  |  |  |  |
| t <sub>ON</sub>     | Turn-On Time                        |   | 27       |              | ms                   |  |  |  |  |
| t <sub>OFF</sub>    | Turn-Off Time                       |   | 1        |              | ms                   |  |  |  |  |

|                    | Parameter                      |            | LM4      |          |                |  |
|--------------------|--------------------------------|------------|----------|----------|----------------|--|
| Symbol             |                                | Conditions | Typical  | Limit    | Units (Limits) |  |
|                    |                                |            | (Note 6) | (Note 7) | (Lillins)      |  |
| AUDIO INTER        | FACE TIMING                    |            |          |          |                |  |
| t <sub>MCLKL</sub> | MCLK Pulse Width Low           |            |          | 16       | ns (min)       |  |
| t <sub>MCLKH</sub> | MCLK Pulse Width High          |            |          | 16       | ns (min)       |  |
| MCLKY              | MCLK Period                    |            |          | 32       | ns (min)       |  |
| t <sub>BCLKR</sub> | BCLK Rise Time                 |            |          | 3        | ns (max        |  |
| BCLKCF             | BCLK Fall Time                 |            |          | 3        | ns (max        |  |
| BCLKDS             | BCLK Duty Cycle                |            | 50       |          | %              |  |
| t <sub>DL</sub>    | LRC Propagation Delay from     |            |          | 10       | ns (max)       |  |
| ·DL                | BCLK falling edge              |            |          | 10       |                |  |
| t <sub>DST</sub>   | DATA Setup Time to BCLK Rising |            |          | 10       | ns (min)       |  |
| 7051               | Edge                           |            |          |          |                |  |
| t <sub>DHT</sub>   | DATA Hold Time from BCLK       |            |          | 10       | ns (min)       |  |
| ואטי               | Rising Edge                    |            |          |          |                |  |
| CONTROL IN         | TERFACE TIMING                 |            |          |          |                |  |
|                    | SCLK Frequency                 |            |          | 400      | kHz (max       |  |
| 1                  | Hold Time (repeated START      |            |          | 0.6      | μs (min)       |  |
| 1                  | Condition)                     |            |          |          |                |  |

|                |  |            | LM4      | l                    |           |  |
|----------------|--|------------|----------|----------------------|-----------|--|
| Symbol         | Parameter  | Conditions | Typical  | Limit                | Units     |  |
|                |  |            | (Note 6) | (Note 7)             | (Limits)  |  |
| 2              | Clock Low Time                                   |            |          | 1.3                  | μs (min)  |  |
| 3              | Clock High Time                                  |            |          | 600                  | ns (min)  |  |
| 4              | Setup Time for a Repeated START Condition        |            |          | 600                  | ns (min)  |  |
|                | Data Hold Time                                   | Output     |          | 300                  | ns (min)  |  |
| 5              |  | Input      |          | 0                    | ns (min)  |  |
|                |  | Imput      |          | 900                  | ns (max)  |  |
| 6              | Data Setup Time                                  |            |          | 100                  | ns (min)  |  |
| 7              | Rise Time of SDA and SCL                         |            |          | 20+0.1C <sub>B</sub> | ns (min)  |  |
| <i>'</i>       | Alse Time of SDA and SCL                         |            |          | 300                  | ns (max)  |  |
| 8              | Fall Time of SDA and SCL                         |            |          | 15+0.1C <sub>B</sub> | ns (min)  |  |
| 0              |  |            |          | 300                  | ns (max)  |  |
| 9              | Setup Time for STOP Condition                    |            |          | 600                  | ns (min)  |  |
| 10             | Bus Free time Between a STOP and START Condition |            |          | 1.3                  | μs ( min) |  |
|                | Bus Capacitance                                  |            |          | 10                   | pF (min)  |  |
| C <sub>B</sub> |  |            |          | 200                  | pF (max)  |  |

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the Recommended Operating Conditions is not implied. The Recommended Operating Conditions indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified

Note 2: The Electrical Characteristics tables list guaranteed specifications under the listed Recommended Operating Conditions except as otherwise modified or specified by the Electrical Characteristics Conditions and/or Notes. Typical specifications are estimations only and are not guaranteed.

Note 3: The maximum power dissipation must be derated at elevated temperatures and is dictated by  $T_{JMAX}$ ,  $\theta_{JA}$ , and the ambient temperature,  $T_A$ . The maximum allowable power dissipation is  $P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA}$  or the number given in *Absolute Maximum Ratings*, whichever is lower.

Note 4: Human body model, applicable std. JESD22-A114C.

Note 5: Machine model, applicable std. JESD22-A115-A.

Note 6: Typical values represent most likely parametric norms at  $T_A = +25^{\circ}C$ , and at the Recommended Operation Conditions at the time of product characterization and are not guaranteed.

Note 7: Datasheet min/max specification limits are guaranteed by test or statistical analysis.

Note 8:  $R_L$  is a resistive load in series with two inductors to simulate an actual speaker load. For  $R_L$  = 8 $\Omega$ , the load is 15 $\mu$ H + 8 $\Omega$  +15 $\mu$ H. For  $R_L$  = 4 $\Omega$ , the load is 15 $\mu$ H + 4 $\Omega$  + 15 $\mu$ H.

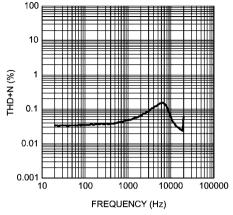
## **Pin Descriptions**

TABLE 1.

| Pin    | Name                 | Description   |
|--------|----------------------|---|
| 1      | C1P                  | Charge Pump Flying Capacitor Positive Terminal                    |
| 2      | CPGND                | Charge Pump Ground  |
| 3      | SDA                  | I <sup>2</sup> C Serial Data Input                                |
| 4      | DGND                 | Digital Ground  |
| 5      | I2S_WS               | I2S Word Select Input   |
| 6      | I <sup>2</sup> S_SDI | I <sup>2</sup> S Serial Data Input                                |
| 7      | I2S_CLK              | I <sup>2</sup> S Clock Input                                      |
| 8      | MCLK                 | Master Clock  |
| 9      | SCL                  | I2C Clock Input   |
| 10     | DV <sub>DD</sub>     | Digital Core Power Supply   |
| 11     | IOV <sub>DD</sub>    | Digital Interface Power Supply                                    |
| 12     | GND                  | Analog Ground   |
| 13     | REF                  | DAC Reference Bypass  |
| 14     | INR                  | Right Channel Analog Input  |
| 15     | INL                  | Left Channel Analog Input   |
| 16     | $V_{DD}$             | Analog Power Supply   |
| 17     | BYPASS               | Mid-Rail Bias Bypass  |
| 18, 24 | LSV <sub>DD</sub>    | Speaker Power Supply  |
| 19     | LLS+                 | Left Channel Non-Inverting Speaker Output                         |
| 20     | LLS-                 | Left Channel Inverting Speaker Output                             |
| 21     | LSGND                | Speaker Ground  |
| 22     | RLS-                 | Right Channel Inverting Speaker Output                            |
| 23     | RLS+                 | Right Channel Non-Inverting Speaker Output                        |
| 25     | HPGND                | Headphone Amplifier Ground  |
| 26     | HPS                  | Headphone Sense Input   |
| 27     | HPR                  | Right Channel Headphone Amplifier Output                          |
| 28     | $HPV_{DD}$           | Headphone Amplifier Power Supply                                  |
| 29     | HPL                  | Left Channel Headphone Amplifier Output                           |
| 30     | $HPV_{SS}$           | Charge Pump Output and Headphone Amplifier Negative Power Supply. |
| 31     | C1N                  | Charge Pump Flying Capacitor Negative Terminal                    |
| 32     | CPV <sub>DD</sub>    | Charge Pump Power Supply  |

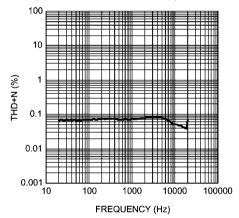
### **Typical Performance Characteristics**

THD+N vs Frequency  ${\rm V_{DD}=3.0V,\,P_{OUT}=50mW,\,R_L=4\Omega}$  DAC Input, Internal Reference, Speaker Mode



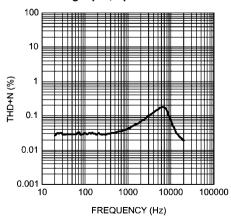
300455b6

THD+N vs Frequency  ${\rm V_{DD}=3.0V,\,P_{OUT}=50mW,\,R_L=4\Omega}$  DAC Input, External Reference, Speaker Mode



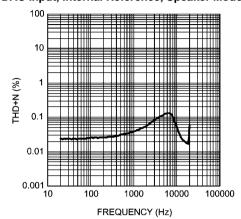
300455c4

THD+N vs Frequency  $\begin{aligned} \text{V}_{\text{DD}} &= 3.0\text{V}, \, \text{P}_{\text{OUT}} = 100\text{mW}, \, \text{R}_{\text{L}} = 4\Omega \\ \text{Analog Input, Speaker Mode} \end{aligned}$ 



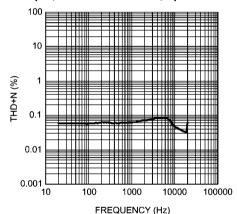
300455d2

THD+N vs Frequency  $\label{eq:VDD} V_{DD}=3.0V,\,P_{OUT}=150mW,\,R_L=8\Omega$  DAC Input, Internal Reference, Speaker Mode



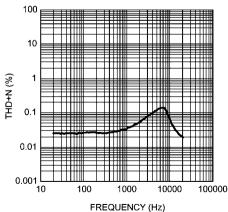
300455b9

THD+N vs Frequency  ${\rm V_{DD}=3.0V,\,P_{OUT}=150mW,\,R_{L}=8\Omega}$  DAC Input, External Reference, Speaker Mode



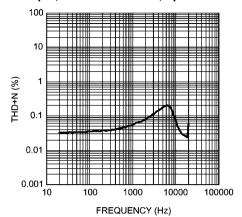
300455c7

THD+N vs Frequency  $\begin{aligned} \mathbf{V}_{\mathrm{DD}} &= 3.0\mathbf{V}, \, \mathbf{P}_{\mathrm{OUT}} = 80 \mathrm{mW}, \, \mathbf{R}_{\mathrm{L}} = 8\Omega \\ &\quad \mathbf{A} \mathrm{nalog \ Input}, \, \mathbf{Speaker \ Mode} \end{aligned}$ 



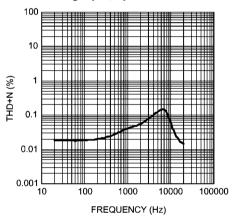
300455d5

THD+N vs Frequency  $\label{eq:VDD} \mathbf{V_{DD}} = 3.6 \text{V, } \mathbf{P_{OUT}} = 100 \text{mW, } \mathbf{R_L} = 4 \Omega$  DAC Input, Internal Reference, Speaker Mode



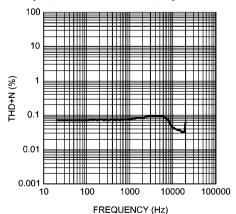
300455b7

THD+N vs Frequency  $V_{DD} = 3.6V, P_{OUT} = 100$ mW,  $R_{L} = 8\Omega$  Analog Input, Speaker Mode



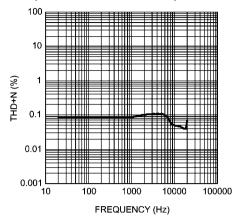
300455d6

THD+N vs Frequency  ${\rm V_{DD}=3.6V,\,P_{OUT}=200mW,\,R_{L}=8\Omega}$  DAC Input, External Reference, Speaker Mode



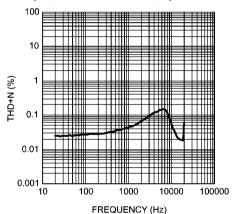
300455c8

THD+N vs Frequency  ${\rm V_{DD}=3.6V,\,P_{OUT}=100mW,\,R_L=4\Omega}$  DAC Input, External Reference, Speaker Mode



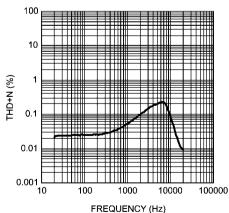
300455c5

THD+N vs Frequency  ${\rm V_{DD}=3.6V,\,P_{OUT}=200mW,\,R_{L}=8\Omega}$  DAC Input, Internal Reference, Speaker Mode



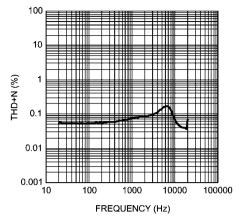
300455c0

THD+N vs Frequency  $V_{DD}$  = 3.6V,  $P_{OUT}$  = 100mW,  $R_{L}$  =  $4\Omega$  Analog Input, Speaker Mode



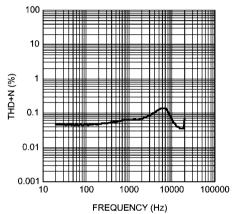
300455d3

THD+N vs Frequency  ${\rm V_{DD}=5.0V,\,P_{OUT}=750mW,\,R_{L}=4\Omega}$  DAC Input, Internal Reference, Speaker Mode



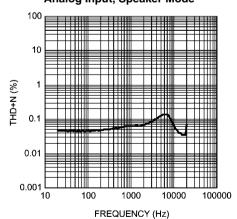
300455b8

THD+N vs Frequency  $\label{eq:VDD} \mathbf{V_{DD}} = 5.0 \text{V}, \, \mathbf{P_{OUT}} = 800 \text{mW}, \, \mathbf{R_L} = 8\Omega$  DAC Input, Internal Reference, Speaker Mode



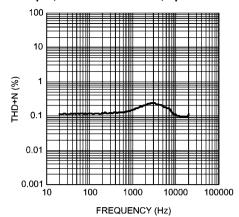
300455c1

THD+N vs Frequency  $V_{DD} = 5.0V, P_{OUT} = 700$ mW,  $R_{L} = 8\Omega$  Analog Input, Speaker Mode



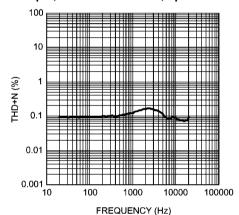
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THD+N vs Frequency  ${\rm V_{DD}=5.0V,\,P_{OUT}=750mW,\,R_{L}=4\Omega}$  DAC Input, External Reference, Speaker Mode



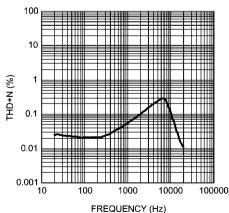
300455c6

THD+N vs Frequency  ${\rm V_{DD}=5.0V,\,P_{OUT}=800mW,\,R_{L}=8\Omega}$  DAC Input, External Reference, Speaker Mode



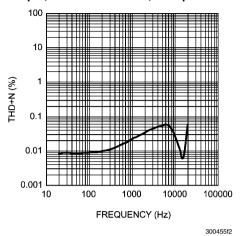
300455c9

THD+N vs Frequency  $V_{DD}$  = 5.0V,  $P_{OUT}$  = 1.0W,  $R_{L}$  =  $4\Omega$  Analog Input, Speaker Mode

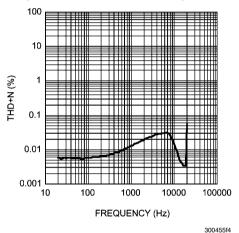


300455d4

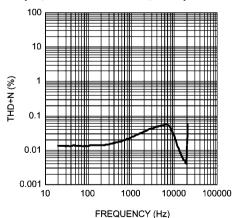
THD+N vs Frequency HPV $_{DD}$  = 2.0V, P $_{OUT}$  = 10mW, R $_{L}$  = 16 $\Omega$  DAC Input, Internal Reference, Headphone Mode



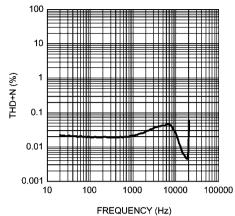
THD+N vs Frequency HPV $_{DD}$  = 2.0V, P $_{OUT}$  = 15mW, R $_{L}$  = 32 $\Omega$  DAC Input, Internal Reference, Headphone Mode



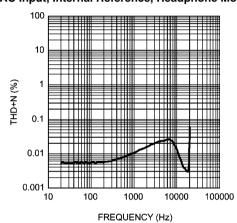
THD+N vs Frequency HPV $_{\rm DD}$  = 2.0V, P $_{\rm OUT}$  = 10mW, R $_{\rm L}$  = 16 $\Omega$  DAC Input, External Reference, Headphone Mode



THD+N vs Frequency HPV $_{DD}$  = 2.5V, P $_{OUT}$  = 25mW, R $_{L}$  = 16 $\Omega$  DAC Input, Internal Reference, Headphone Mode



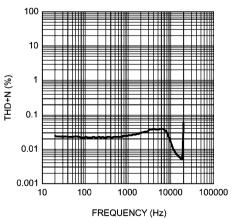
THD+N vs Frequency HPV $_{\rm DD}$  = 2.5V, P $_{\rm OUT}$  = 25mW, R $_{\rm L}$  = 32 $\Omega$  DAC Input, Internal Reference, Headphone Mode



300455f5

300455f3

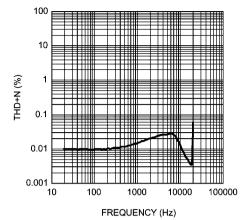
THD+N vs Frequency HPV $_{\rm DD}$  = 2.5V, P $_{\rm OUT}$  = 25mW, R $_{\rm L}$  = 16 $\Omega$  DAC Input, External Reference, Headphone Mode



300455f9

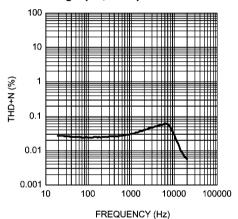
300455f8

THD+N vs Frequency HPV $_{\rm DD}$  = 2.0V, P $_{\rm OUT}$  = 15mW, R $_{\rm L}$  = 32 $\Omega$  DAC Input, External Reference, Headphone Mode



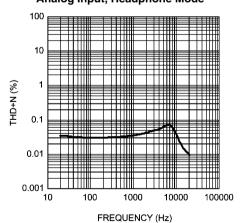
300455g0

THD+N vs Frequency HPV $_{\rm DD}$  = 2.0V, P $_{\rm OUT}$  = 10mW, R $_{\rm L}$  = 16 $\Omega$  Analog Input, Headphone Mode



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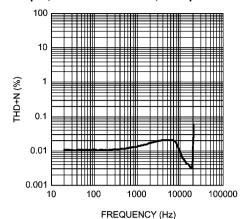
THD+N vs Frequency HPV $_{\rm DD}$  = 2.5V, P $_{\rm OUT}$  = 15mW, R $_{\rm L}$  = 16 $\Omega$  Analog Input, Headphone Mode



300455g8

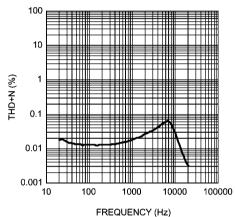
300455g7

THD+N vs Frequency HPV $_{\rm DD}$  = 2.0V, P $_{\rm OUT}$  = 25mW, R $_{\rm L}$  = 32 $\Omega$  DAC Input, External Reference, Headphone Mode



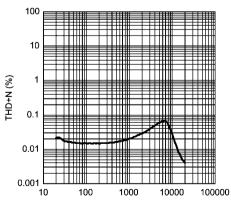
300455g1

THD+N vs Frequency HPV $_{\rm DD}$  = 2.0V, P $_{\rm OUT}$  = 10mW, R $_{\rm L}$  = 32 $\Omega$  Analog Input, Headphone Mode



300455q9

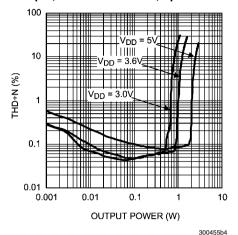
THD+N vs Frequency HPV<sub>DD</sub> = 2.5V,  $P_{OUT}$  = 15mW,  $R_L$  = 32 $\Omega$  Analog Input, Headphone Mode



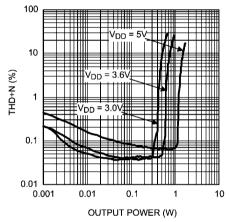
FREQUENCY (Hz)

300455h0

## THD+N vs Output Power $A_V=12\text{dB, }R_L=4\Omega, \text{f}=1\text{kHz}$ DAC Input, Internal Reference, Speaker Mode



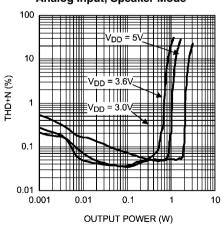
## THD+N vs Output Power ${\bf A_V=12dB,\,R_L=8\Omega,\,f=1kHz}$ DAC Input, Internal Reference, Speaker Mode



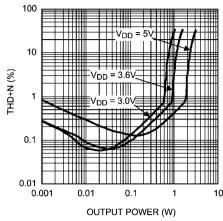
300455b5

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THD+N vs Output Power  $A_V = 6dB$ ,  $R_L = 4\Omega$ , f = 1kHz Analog Input, Speaker Mode

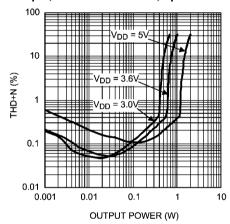


THD+N vs Output Power  $A_V = 12 \text{dB, } R_L = 4\Omega, \text{f} = 1 \text{kHz}$  DAC Input, External Reference, Speaker Mode



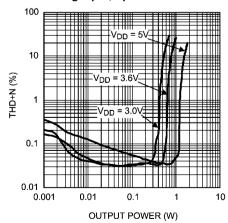
300455c2

THD+N vs Output Power  $A_V = 12dB, R_L = 8\Omega, f = 1kHz$  DAC Input, External Reference, Speaker Mode



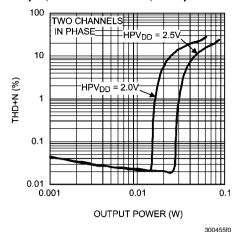
300455c3

THD+N vs Output Power  $A_V = 6dB$ ,  $R_L = 8\Omega$ , f = 1kHz Analog Input, Speaker Mode

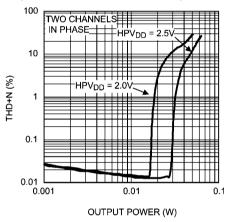


300455d1

THD+N vs Output Power  $A_V=9\text{dB, }R_L=16\Omega, \text{ }f=1\text{kHz}$  DAC Input, Internal Reference, Headphone Mode



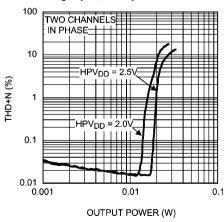
THD+N vs Output Power  $A_V=9\text{dB},\,R_L=32\Omega,\,f=1\text{kHz}$  DAC Input, External Reference, Headphone Mode



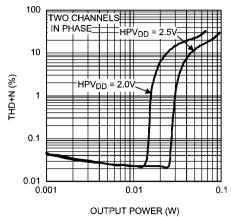
THD+N vs Output Power  $A_V = 0$ dB,  $R_L = 32\Omega$ , f = 1kHz Analog Input, Headphone Mode

300455f7

300455g6



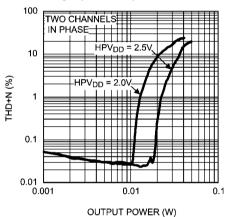
THD+N vs Output Power  $A_V=9$ dB,  $R_L=16\Omega$ , f=1kHz DAC Input, External Reference, Headphone Mode



+N vs Output Power

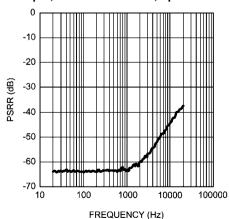
300455f6

THD+N vs Output Power  $A_V = 0$ dB,  $R_L = 16\Omega$ , f = 1kHz Analog Input, Headphone Mode



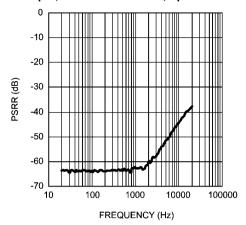
300455g5

PSRR vs Frequency  $\label{eq:VDD} \begin{aligned} &V_{DD}=3.6V,\,V_{RIPPLE}=200mV_{p.p},\,R_L=8\Omega\\ &\text{DAC Input, Internal Reference, Speaker Mode} \end{aligned}$ 



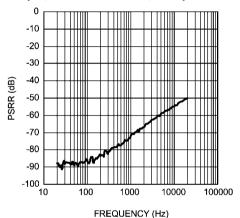
300455e4

PSRR vs Frequency  $\label{eq:VDD} \textbf{V}_{\text{DD}} = 3.6 \text{V}, \ \textbf{V}_{\text{RIPPLE}} = 200 \text{mV}_{\text{P.p.}}, \ \textbf{R}_{\text{L}} = 8 \Omega$  DAC Input, External Reference, Speaker Mode



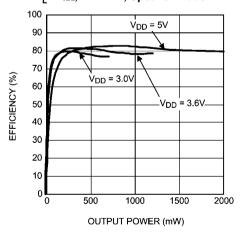
300455e5

 $\begin{array}{l} \text{PSRR vs Frequency} \\ \text{HPV}_{\text{DD}} = 2.5\text{V}, \text{V}_{\text{RIPPLE}} = 200\text{mV}_{\text{P.P}}, \text{R}_{\text{L}} = 32\Omega \\ \text{DAC Input, Internal Reference, Headphone Mode} \end{array}$ 



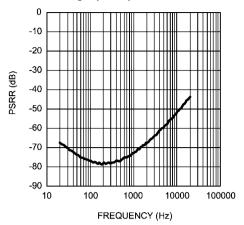
300455g2

Efficiency vs Output Power  $R_L = 4\Omega$ , f = 1kHz, Speaker Mode



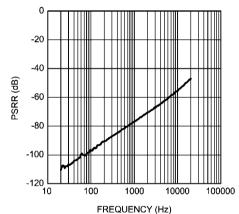
300455d8

 $\begin{array}{c} \text{PSRR vs Frequency} \\ \text{V}_{\text{DD}} = 3.6\text{V}, \text{V}_{\text{RIPPLE}} = 200\text{mV}_{\text{p.p.}}, \text{R}_{\text{L}} = 8\Omega \\ \text{Analog Input, Speaker Mode} \end{array}$ 



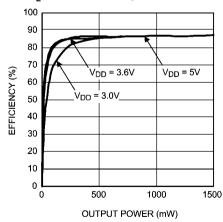
300455e7

 $\begin{array}{c} \text{PSRR vs Frequency} \\ \text{HPV}_{\text{DD}} = 2.5\text{V}, \, \text{V}_{\text{RIPPLE}} = 200\text{mV}_{\text{P-P}}, \, \text{R}_{\text{L}} = 32\Omega \\ \text{Analog Input, Headphone Mode} \end{array}$ 



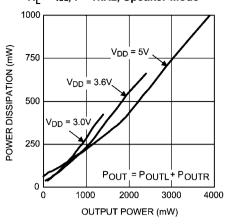
300455h5

Efficiency vs Output Power  $R_L = 8\Omega$ , f = 1kHz, Speaker Mode



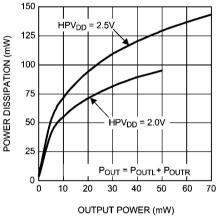
30045520

## Power Dissipation vs Output Power $R_1 = 4\Omega$ , f = 1kHz, Speaker Mode



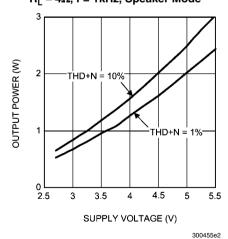
300455e

## Power Dissipation vs Output Power $R_L = 16\Omega$ , f = 1kHz, Headphone Mode

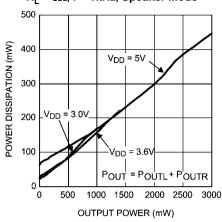


300455h1

## Output Power vs Supply Voltage $R_L = 4\Omega$ , f = 1kHz, Speaker Mode

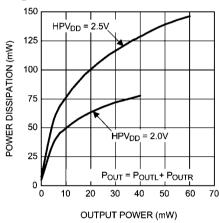


Power Dissipation vs Output Power  $R_1 = 8\Omega$ , f = 1kHz, Speaker Mode



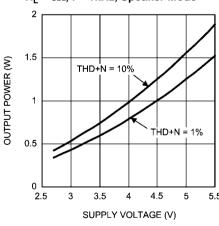
300455e1

## Power Dissipation vs Output Power $R_L = 32\Omega$ , f = 1kHz, Headphone Mode



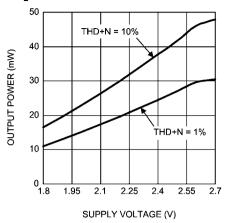
300455h2

## Output Power vs Supply Voltage $R_L = 8\Omega$ , f = 1kHz, Speaker Mode



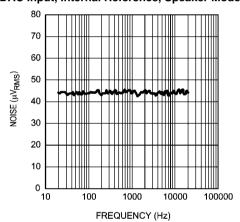
300455e3

## Output Power vs Supply Voltage $R_1 = 16\Omega$ , f = 1kHz, Headphone Mode



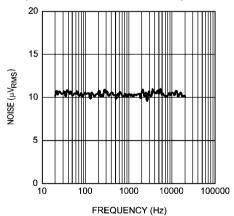
300455h3

## Output Noise vs Frequency ${\rm V_{DD}=3.6V,\,R_L=8\Omega}$ DAC Input, Internal Reference, Speaker Mode



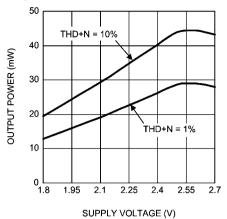
300455e6

## Output Noise vs Frequency $\label{eq:VDD} {\rm V_{DD}} = 2.5 {\rm V, R_L} = 32 \Omega$ DAC Input, Internal Reference, Headphone Mode



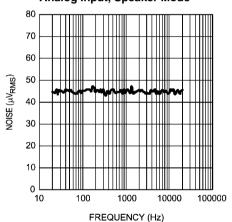
300455g4

## Output Power vs Supply Voltage $R_1 = 32\Omega$ , f = 1kHz, Headphone Mode



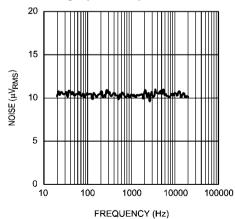
300455h4

## Output Noise vs Frequency $V_{DD}$ = 3.6V, $R_L$ = $8\Omega$ Analog Input, Speaker Mode



300455e8

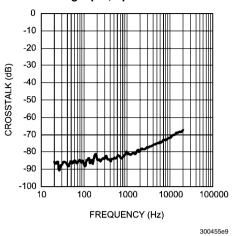
## Output Noise vs Frequency $\mathrm{HPV}_\mathrm{DD} = 2.5\mathrm{V},\,\mathrm{R}_\mathrm{L} = 32\Omega$ Analog Input, Headphone Mode



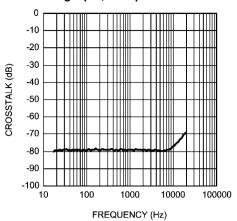
300455h6

19

Crosstalk vs Frequency  $V_{DD}=3.6V,\,V_{RIPPLE}=1V_{P.P},\,R_L=8\Omega$  Analog Input, Speaker Mode



## Crosstalk vs Frequency $V_{DD}$ = 2.5V, $V_{RIPPLE}$ = $1V_{P.P}$ , $R_L$ = $8\Omega$ Analog Input, Headphone Mode



300455h7

### **Application Information**

#### 12C COMPATIBLE INTERFACE

The LM49450 is controlled through an I<sup>2</sup>C compatible serial interface that consists of a serial data line (SDA) and a serial clock (SCL). The clock line is uni-directional. The data line is bi-directional (open collector). The LM49450 and the master can communicate at clock rates up to 400kHz. Figure 2 shows the I<sup>2</sup>C interface timing diagram. Data on the SDA line must be stable during the HIGH period of SCL. The LM49450 is a

transmit/receive slave-only device, reliant upon the master to generate the SCL signal. Each transmission sequence is framed by a START condition and a STOP condition (Figure 3). Each data word, register address and register data, transmitted over the bus is 8 bits long as is always followed by and acknowledge pulse (Figure 3). The LM49450 device address is 1111101

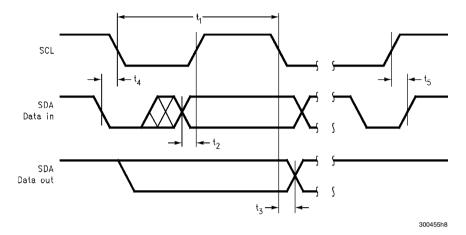


FIGURE 2. I2C Timing Diagram

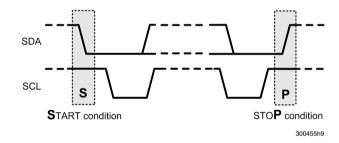


FIGURE 3. START and STOP Diagram



FIGURE 4. Example I2C Write Cycle

21

#### **BUS FORMAT**

The I<sup>2</sup>C bus format is shown in Figure 4. The START signal, the transition of SDA from HIGH to LOW while SDA is HIGH, is generated, altering all devices on the bus that a device address is being written to the bus.

The 7-bit device address is written to the bus, most significant bit (MSB) first, followed by the  $R/\overline{W}$  bit ( $R/\overline{W}=0$  indicates the master is writing to the LM49450,  $R/\overline{W}=1$  indicates the master wants to read data from the LM49450). The data is latched in on the rising edge of the clock. Each address bit must be stable while SDA is HIGH. After the last address bit is trans-

mitted, the master device releases SDA, during which time, an acknowledge clock pulse is generated by the slave device. If the LM49450 receives the correct address, the device pulls the SDA line low, generating and acknowledge bit (ACK).

Once the master device registers the ACK bit, the 8-bit register address word is sent. Each data bit should be stable while SCL is HIGH. After the 8-bit register address is sent, the LM49450 sends another ACK bit. Following the acknowledgement of the register address, the 8-bit register data word is sent. Each data bit should be stable while SCL is HIGH. After the 8-bit register data is sent, the LM49450 sends an-

other ACK bit. Following the acknowledgement of the register data word, the master issues a STOP bit, allowing SDA to go high while SDA is high.

#### **I2S DATA FORMAT**

The LM49450 supports three I<sup>2</sup>S formats: Normal Mode (Figure 5), Left Justified Mode (Figure 6), and Right Justified

Mode (Figure 7). In Normal Mode, the audio data is transmitted MSB first, with the unused bits following the LSB. In Left Justified Mode, the audio data format is similar to the Normal Mode, without the delay between the LSB and the change in I<sup>2</sup>S\_WS. In Right Justified Mode, the audio data MSB is transmitted after a delay of a preset number of bits.

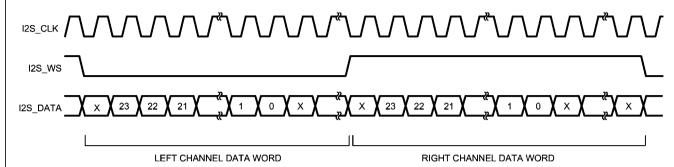


FIGURE 5. I2S Normal Input Format

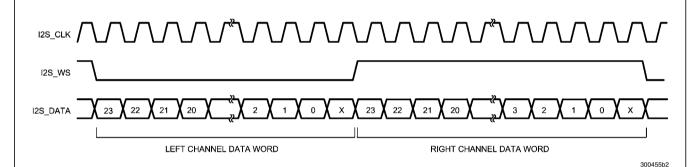
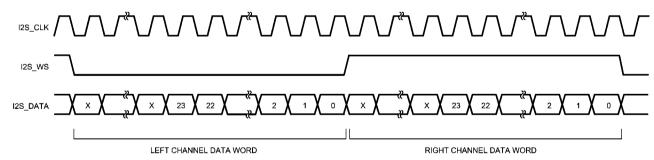


FIGURE 6. I2S Left Justified Input Format



300455b3

300455a9

FIGURE 7. I<sup>2</sup>S Right Justified Input Format

#### **GENERAL AMPLIFIER FUNCTION**

#### **Class D Amplifier**

The LM49450 features a high-efficiency stereo Class D audio power amplifier that utilizes National's filterless modulation scheme which reduces external component count, conserves board space and reduces system cost. The Class D outputs transition between  $\rm V_{\rm DD}$  and GND with a 300kHz switching frequency. With no signal applied, the outputs switch with a 50% duty cycle, in phase, causing the two outputs to cancel.

This cancellation results in no net voltage across the speaker, thus there is no current to the load in the idle state.

With the input signal applied, the duty cycle (pulse width) of the LM49450 outputs changes. For increasing output voltage, the duty cycle of V\_LS+ increases while the duty cycle of V\_LS- decreases. For decreasing output voltages, the converse occurs. The difference between the two pulse widths yield the differential output voltage.

#### **Fixed Frequency Mode**

The LM49450 features two modulation schemes, a fixed frequency mode and a spread spectrum mode. Select the fixed frequency mode by setting the SS bit (B3) in the Mode Control Register (0x00h) to 0. In fixed frequency mode, the speaker amplifier outputs switch at a constant 300kHz. The output spectrum in fixed frequency mode consists of the fundamental and its associated harmonics (see *Typical Performance Characteristics*).

#### **Spread Spectrum**

The logic selectable spread spectrum mode eliminates the need for output filters, ferrite beads or chokes. In spread spectrum mode, the switching frequency varies randomly by 30% about a 300kHz center frequency, reducing the wideband spectral content, improving EMI emissions radiated by the speaker and associated cables and traces. Where a fixed frequency class D exhibits large amounts of spectral energy at multiples of the switching frequency, the spread spectrum architecture of the LM49450 spreads that energy over a larger bandwidth (see Typical Performance Characteristics). The cycle-to-cycle variation of the switching period does not affect the audio reproduction, efficiency, or PSRR. Set the SS bit (B3) in the Mode Control Register (0x00h) to 1 to select spread spectrum mode.

#### **Headphone Amplifier**

The LM49450 headphone amplifiers feature National's ground referenced architecture that eliminates the large DC-blocking capacitors required at the outputs of traditional headphone amplifiers. A low-noise inverting charge pump creates a negative supply (HPV $_{SS}$ ) from the positive supply voltage (CPV $_{DD}$ ). The headphone amplifiers operate from these bipolar supplies, with the amplifier outputs biased about GND, instead of a nominal DC voltage (typically  $V_{DD}/2$ ), like traditional amplifiers. Because there is no DC component to the headphone output signals, the large DC-blocking capacitors (typically 220µF) are not necessary, conserving board space and system cost, while improving frequency response.

#### **Power Supplies**

The LM49450 uses different power supplies for each portion of the device, allowing for the optimum combination of headroom, power dissipation and noise immunity. The analog input, and gain (volume control) stages for both speaker and headphones are powered from  $V_{DD}$ . The speaker output stage is powered from LSV $_{DD}$ . The headphone amplifiers and charge pump are powered from HPV $_{DD}$ . The separate power supplies allow the class D amplifiers to operate from a higher voltage, maximizing headroom, while the headphones operate from a lower voltage, improving power dissipation, as well as minimizing switching noise coupling between the speaker and headphone amplifiers. The digital portion of the device is powered from DV $_{DD}$ , including the 3D processing core and DAC. IOV $_{DD}$  powers the I²S and I²C, allowing the LM49450 to interface with lower voltage digital controllers.

#### National's 3D Enhancement

The LM49450 digital audio path features National's 3D enhancement that widens or narrows the perceived soundstage of a stereo audio signal. The 3D enhancement either increases or decreases the apparent stereo channel separation, improving audio reproduction whenever the placement of both left and right speakers is not ideal.

The LM49450 3D function is controlled through the I<sup>2</sup>C interface. The headphone and speakers have independent 3D controls, allowing each signal path to have its own individual

3D configuration. The LM49450 3D features two effect modes, a narrow effect that decreases the channel separation, making the speakers sound closer together, and a wide effect that makes the speakers sound farther apart. Because the narrow effect mode adds a portion of the left and right signals together, a selectable 6dB attenuation mode is provided to maintain a constant output amplitude when the narrow effect mode is active without changing the volume level. The high pass 3dB roll off frequency, 3D gain (amount channel mixing), and narrow/wide effect selection is done through registers 0x05h (headphone) and 0x06h (speaker. See the Headphone 3D Configuration Register and Loudspeaker 3D Control Register sections for more information.

#### **Headphone Sense**

The LM49450 features a headphone sense input (HPS) that monitors the headphone jack and configures the device depending on the presence of a headphone. When the HPS pin is low, indicating that a headphone is not present, the LM49450 speaker amplifiers are active and the headphone amplifiers are disabled. When the HPS pin is high, indicating that a headphone is present, the headphone amplifiers are active while the speaker amplifiers are disabled.

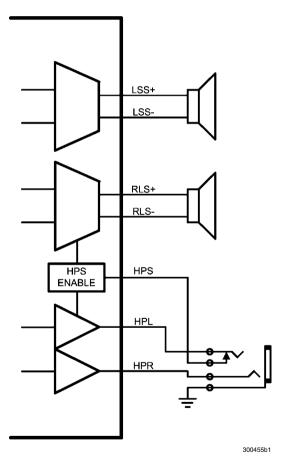


FIGURE 8. HPS Connection

#### **Volume Control**

The LM49450 features two separate 32-step volume controls, one for the speaker channels and one for the headphone channels. This allows for the gain of the headphone and speakers to be set independently of each other.

#### **External Reference**

The LM49450 can be used with an external reference. Disable the internal reference by setting bit B7 of the Mode Control Register (0x00h) to 1. This allows an external reference voltage to be applied to REF. For proper operation, do not allow the  $V_{\rm REF}$  to exceed  $V_{\rm DD}$ .

#### **Low Power Shutdown**

The LM49450 features an I<sup>2</sup>C selectable low power shutdown mode that disables the entire device, reducing quiescent current consumption to  $0.05\mu A$  (digital + analog current). Set bit B0 in the mode control register (0x00h) to 0 to disable the device. Set B0 to 1 to enable the device.

#### **12S CLOCK CONTROL**

The LM49450 features the ability to derive multiple clock signals, including the DAC clock, I2S clock and word select clock in master mode, and the charge pump oscillator frequency, from the MCLK input.

#### **DAC Clock Divider (RDIV)**

Bits B5-B0 in the CLOCK CONTROL register (0x01h) are the RDIV bits that set the DAC clock divider ratio. The DAC clock derived from MCLK needs to match the DAC sampling rate. For example, with  $f_{\rm MCLK} = 12.288 \rm MHz$  and a  $64^* f_{\rm S}$  oversam-

pling ratio ( $f_S = 48 \text{kHz}$ ), the DAC requires a 6.144MHz clock. In this case, set the RDIV ratio to divide by 2. In other instances, there may not be a suitable divider ratio for a given sampling rate and MCLK frequency. In this case,  $f_{\text{MCLK}}$  may need to be altered. See the *Clock Control Register* section for more information.

#### I2S WS Clock Dividers (I2S\_CLK, WS\_CLK)

In I²S master mode, the LM49450 I2S CLOCK CONTROL register (0x04h) can be used to set the I²S clock and WS clock frequency. In I2S clock master mode, bits B7-B4 of the I2S CLOCK CONTROL register, the I2S\_CLK bits, set the I²S clock divider ratio. The LM49450 derives the I²S clock from DAC clock based on the ratio set by the I2S\_CLK bits. The I²S clock is output on I²S\_CLK.

In I<sup>2</sup>S master mode, bits B3 and B2 (I<sup>2</sup>S\_WS) of the I<sup>2</sup>S CLOCK CONTROL register set the bit length per data word of the I<sup>2</sup>S WS.

#### **Charge Pump Clock Divider (CPDIV)**

The ground referenced headphone amplifiers charge pump derives its clock from MCLK. Bits B7-B0 of the CHARGE PUMP CLOCK register (0x02h) set the charge pump clock divider ratio. See the *Charge Pump Clock Register* section for more information.

|                                  | B0                 | ENABLE      | RDIV_0             | CPDIV_0                        | I2S_MODE_0             | I2S_CLK_MS | HP_3DEN                 | LS_3DEN            | 0HH                         | rs0                       | CO_0      | C0_08     | C1_0      | C1_08     | C2_0      | C2_08     |
|----------------------------------|--------------------|-------------|--------------------|--------------------------------|------------------------|------------|-------------------------|--------------------|-----------------------------|---------------------------|-----------|-----------|-----------|-----------|-----------|-----------|
|                                  | B1                 | LINE_IN     | RDIV_1             | CPDIV_1                        | I2S_MODE_1_            | I2S_WS_MS  | HP_3D_MODE              | LS_3D_MODE         | HP1                         | LS1                       | C0_1      | C0_09     | C1_1      | C1_09     | C2_1      | C2_09     |
|                                  | B2                 | MUTE        | RDIV_2             | CPDIV_2                        | I2S_WORD<br>_ORDER     | I2S_WS_0   | HP_3D_GAIN_0            | LS_3DGAIN_0        | HP2                         | LS2                       | C0_2      | C0_10     | C1_2      | C1_10     | C2_2      | C2_10     |
| de                               | В3                 | SS          | RDIV_3             | CPDIV_3                        | I2S STEREO<br>_REVERSE | I2S_WS_1   | HP_3D_GAIN_1            | LS_3DGAIN_1        | НРЗ                         | rs3                       | C0_3      | C0_111    | C1_3      | C1_11     | C2_3      | C2_11     |
| :RS — Register Ma                | B4                 | COMP        | RDIV_4             | CPDIV_4                        | I2S_WRD_0              | I2S_CLK_0  | HP_3DFREQ_0             | LS_3DFREQ_0        | HP4                         | LS4                       | C0_4      | C0_12     | C1_4      | C1_12     | C2_4      | C2_12     |
| CONTROL REGISTERS — Register Map | B5                 | DAC_MODE_ 0 | RDIV_5             | CPDIV_5                        | I2S_WRD_1              | I2S_CLK_1  | HP_3DFREQ_1             | LS_3DFREQ_1        | RESERVED                    | RESERVED                  | C0_5      | C0_13     | C1_5      | C1_13     | C2_5      | C2_13     |
| ŏ                                | 98                 | DAC_MODE_1  | DAC_DITHER<br>_ON  | CPDIV_6                        | I2S_WRD_2              | I2S_CLK_2  | HP_3DATTN               | LS_3DATTN          | RESERVED                    | RESERVED                  | 9_00      | C0_14     | C1_6      | C1_14     | C2_6      | C2_14     |
|                                  | 28                 | EXT_REF     | DAC_DITHER<br>_OFF | CPDIV_7                        | RESERVED               | I2S_CLK_3  | RESERVED                | RESERVED           | RESERVED                    | RESERVED                  | C0_7      | C0_15     | C1_7      | C1_15     | C2_7      | C2_15     |
|                                  | Register<br>Name   | MODE        | СГОСК              | CHARGE PUMP CLOCK<br>FREQUENCY | I2S MODE               | ISS CLOCK  | HEADPHONE 3D<br>CONTROL | SPEAKER 3D CONTROL | HEADPHONE VOLUME<br>CONTROL | SPEAKER VOLUME<br>CONTROL | CMP_0_LSB | CMP_0_MSB | CMP_1_LSB | CMP_1_MSB | CMP_2_LSB | CMP_2_MSB |
|                                  | Register<br>Addess | 0x00h       | 0x01h              | 0x02h                          | 0x03h                  | 0x04h      | 0x05h                   | 0x06h              | 0x07h                       | 0x08h                     | 0×09h     | 0x0Ah     | 0x0Bh     | 0x0Ch     | 0x0Dh     | 0x0Eh     |

#### **MODE CONTROL REGISTER (0x00h)**

Default value is 0x00h.

**TABLE 2. Mode Control Register** 

| Bit   | Name                                 | Value |    | Description   |
|-------|--------------------------------------|-------|----|---|
|       |                                      |       | 0  | Internal reference selected   |
| В7    | EXT_REF                              | 1     |    | External reference selected. See External Reference section.                        |
|       |                                      | B6    | B5 | Select DAC over sampling Rate   |
|       | DAG MODE 4 (DO)                      | 0     | 0  | 125   |
| B6:B5 | DAC_MODE_1 (B6)  <br>DAC_MODE_0 (B5) | 0     | 1  | 128   |
|       | DAC_MODE_0 (B3)                      | 1     | 0  | 64  |
|       |                                      | 1     | 1  | 32  |
|       |                                      |       | 0  | Default DAC compensation filter selected  |
| B4    | COMP                                 |       | 1  | Programmable DAC compensation filter selected. See DAC Compensation Filter section. |
| B3    | SS                                   |       | 0  | Fixed frequency oscillator selected   |
| ВЗ    | 55                                   |       | 1  | Spread spectrum oscillator selected   |
| B2    | MUTE                                 |       | 0  | Un-mute device  |
| DZ    | MOTE                                 |       | 1  | Mute device   |
| В0    | ENABLE                               | 0     |    | Device shutdown. Default state during a POR event                                   |
| ВО    | EINADLE                              |       | 1  | Device enabled.   |

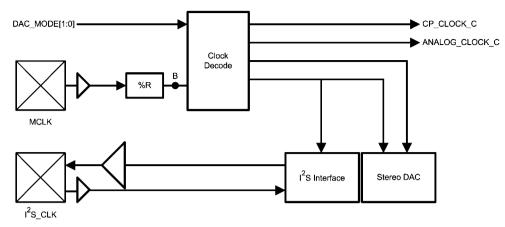
#### CLOCK CONTROL REGISTER (0x01h)

Default value is 0x00h.

**TABLE 3. Clock Control Register** 

| Bit           | Name                       | Value |    |    |    |    | Description       |                                 |
|---------------|----------------------------|-------|----|----|----|----|-------------------|---------------------------------|
| DAO DITUED OF | (                          | )     |    |    |    |    | Default DAC state |                                 |
| B7            | DAC_DITHER_OFF             |       | 1  |    |    |    |                   | Permanently disables DAC dither |
| B6            | DAC DITHER ON              | (     | )  |    |    |    |                   | Default DAC state               |
| D0            | DAC_DITHER_ON              |       | 1  |    |    |    |                   | Permanently enables DAC dither  |
|               |                            | B5    | B4 | В3 | B2 | B1 | B0                | Sets MCLK divider ratio         |
|               |                            | 0     | 0  | 0  | 0  | 0  | 0                 | Bypass divider                  |
|               |                            | 0     | 0  | 0  | 0  | 0  | 1                 | 1                               |
|               | RDIV_5 (B5)                | 0     | 0  | 0  | 0  | 1  | 0                 | 1.5                             |
|               | RDIV_4 (B4)                | 0     | 0  | 0  | 0  | 1  | 1                 | 2                               |
| B5:B0         | RDIV_3 (B3)<br>RDIV_2 (B2) | 0     | 0  | 0  | 1  | 0  | 0                 | 2.5                             |
|               | RDIV_2 (B2)                | 0     | 0  | 0  | 1  | 0  | 1                 | 5                               |
|               | RDIV_0 (B0)                |       |    | Т  | O  |    |                   | In 0.5 increments               |
|               |                            | 1     | 1  | 1  | 1  | 0  | 1                 | 31                              |
|               |                            | 1     | 1  | 1  | 1  | 1  | 0                 | 31.5                            |
|               |                            | 1     | 1  | 1  | 1  | 1  | 1                 | 32                              |

#### **CLK NETWORK**



#### **CLK Network Diagram**

30045559

#### LM49450 Clock Structure

The MCLK input is first divided by the R divider to product the clock at point B; this is then decoded according to the DAC\_MODE to produce a signal which goes to both the DAC digital and the I2S interface, and a signal which goes to the DAC analog.

This table describes the relationship between the clocks, for each of the four possible DAC modes in terms of audio input sampling frequency fs.

TABLE 4. Relationship between clocks for each of the four DAC modes

| DAC MODE | Description |          |                 |                |  |  |
|----------|-------------|----------|-----------------|----------------|--|--|
|          | OSR         | CLK at B | DAC Digital CLK | DAC Analog CLK |  |  |
| 00       | 125         | 250fs    | 250fs           | 125fs          |  |  |
| 01       | 128         | 256fs    | 128fs           | 128fs          |  |  |
| 10       | 64          | 128fs    | 128fs           | 64fs           |  |  |
| 11       | 32          | 128fs    | 128fs           | 32fs           |  |  |

#### **Common Clock Settings for the DAC**

In DAC\_MODE 0, the DAC has an oversampling rate (OSR) of 125 but requires a 250xfs clock at point B. This allows a simple clocking solution as it will work from 12.000MHz (common in most systems with Bluetooth or USB) at 48kHz exact-

ly. In the other DAC modes, the DAC requires a conventional 2^Nxfs clock for conversation. The following table describes the clock required at point B for various clock sample rates in the different DAC modes:

**TABLE 5. Common DAC Clock Frequencies** 

| Sample Rate |                     |                           |                    |                    |
|-------------|---------------------|---------------------------|--------------------|--------------------|
|             | DAC MODE = 2b00     | DAC MODE = 2b01 (OSR      | DAC MODE = 2b10    | DAC MODE = 2b11    |
|             | (OSR = 125fs, Clock | = 128fs, Clock Required = | (OSR = 64fs, Clock | (OSR = 32fs, Clock |
|             | Required = 250fs)   | 256fs)                    | Required = 128fs)  | Required = 128fs)  |
| 8           | 2                   | 2.048                     | _                  | _                  |
| 11.025      | 2.75625             | 2.8224                    | _                  | _                  |
| 12          | 3                   | 3.072                     | _                  | _                  |
| 16          | 4                   | 4.096                     | _                  | _                  |
| 22.05       | 5.5125              | 5.6448                    | _                  | _                  |
| 24          | 6                   | 6.144                     | _                  | _                  |
| 32          | 8                   | 8.192                     | _                  | _                  |
| 44.1        | 11.025              | 11.2896                   | _                  | _                  |
| 48          | _                   | 12.288                    | _                  | _                  |
| 88.2        | _                   | _                         | 11.2896            | _                  |
| 96          | _                   | _                         | 12.288             | _                  |
| 176.4       | _                   | _                         | _                  | 22.5792            |
| 192         | _                   | _                         | _                  | 24.576             |

#### **CHARGE PUMP CLOCK REGISTER (0x02h)**

The charge pump clock register sets the charge pump frequency derived from MCLK when the LM49450 is in DAC mode. Default value is for register 02h is 0x49h.

**TABLE 6. Charge Pump Clock Register** 

| Bit   | Name                       |    |    |    | Va | lue |    |    |    | Description  |
|-------|----------------------------|----|----|----|----|-----|----|----|----|--|
|       | CPDIV_7<br>(B7)<br>CPDIV_6 | B7 | В6 | B5 | B4 | B3  | B2 | B1 | В0 | Sets charge pump oscillator frequency in DAC mode (derived from MCLK). |
|       | (B6)                       | 0  | 0  | 0  | 0  | 0   | 0  | 0  | 0  | Bypass divider   |
|       | CPDIV_5                    | 0  | 0  | 0  | 0  | 0   | 0  | 0  | 1  | 1  |
|       | (B5)<br>CPDIV_4            | 0  | 0  | 0  | 0  | 0   | 0  | 1  | 0  | 1.5  |
|       | (B4)                       | 0  | 0  | 0  | 0  | 0   | 0  | 1  | 1  | 2  |
| B7:B0 | CPDIV_3                    | 0  | 0  | 0  | 0  | 0   | 1  | 0  | 0  | 2.5  |
|       | (B3)                       | 0  | 0  | 0  | 0  | 0   | 1  | 0  | 1  | 3  |
|       | CPDIV_2                    |    |    | Т  | 0  |     |    |    |    | In 0.5 increments  |
|       | (B2)                       | 1  | 1  | 1  | 1  | 1   | 1  | 0  | 1  | 127  |
|       | CPDIV_1                    | 1  | 1  | 1  | 1  | 1   | 1  | 1  | 0  | 127.5  |
|       | (B1)<br>CPDIV_0<br>(B0)    | 1  | 1  | 1  | 1  | 1   | 1  | 1  | 1  | 128  |

#### **CP\_DIV REGISTER**

#### **LM49450 Clock Structure**

This register is used to control the charge pump clock when the register field LINE\_IN\_ENABLE is low i.e. DAC mode.

When the register field LINE\_IN\_ENABLE is high, the Clocks module is held in reset and as a result no CP\_CLOCK\_C is produced.

TABLE 7. CP\_DIV Default Value 0x49h

| Bits | Field  | Desc     | ription                              |
|------|--------|----------|--------------------------------------|
| 7:0  | CP_DIV | ·        | les from an expected 12.000MHz put). |
|      |        | CP_DIV   | Divide Value                         |
|      |        | 0        | Bypass                               |
|      |        | 1        | 1                                    |
|      |        | 2        | 1.5                                  |
|      |        | 3        | 2                                    |
|      |        | 4        | 2.5                                  |
|      |        | 5 to 253 | 3 to 127                             |
|      |        | 254      | 127.5                                |
|      |        | 255      | 128                                  |

Examples of CP\_DIV Values one might use for various sample rates and DAC modes

TABLE 8. Typical CP\_DIV Values for DAC Mode 00

| MCLK (MHZ) | CP_DIV | Nominal Frequency (Hz) |
|------------|--------|------------------------|
| 2          | 11     | 333333                 |
| 2.75625    | 16     | 324265                 |
| 3          | 17     | 333333                 |
| 4          | 23     | 333333                 |
| 5.5125     | 33     | 324264                 |
| 6          | 36     | 324324                 |
| 8          | 48     | 326530                 |

| MCLK (MHZ) | CP_DIV | Nominal Frequency (Hz) |
|------------|--------|------------------------|
| 11.025     | 67     | 324265                 |
| 12         | 73     | 324324                 |

#### TABLE 9. Typical CP\_DIV Values for DAC Mode 01

| MCLK (MHZ) | CP_DIV | Nominal Frequency (Hz) |
|------------|--------|------------------------|
| 2.048      | 11     | 341333                 |
| 2.8224     | 17     | 313600                 |
| 3.072      | 18     | 323368                 |
| 4.096      | 24     | 327680                 |
| 5.6448     | 33     | 332047                 |
| 6.144      | 37     | 323368                 |
| 8.192      | 49     | 327680                 |
| 11.2896    | 68     | 327234                 |
| 12.288     | 75     | 323368                 |

#### TABLE 10. Typical CP\_DIV Values for DAC Mode 10

| MCLK (MHZ) | CP_DIV | Nominal Frequency (Hz) |
|------------|--------|------------------------|
| 11.2896    | 68     | 327234                 |
| 12.288     | 75     | 323368                 |

#### TABLE 11. Typical CP\_DIV Values for DAC Mode 11

| MCLK (MHZ) | CP_DIV | Nominal Frequency (Hz) |
|------------|--------|------------------------|
| 22.5792    | 138    | 324881                 |
| 24.576     | 150    | 325510                 |

#### **I2S MODE CONTROL REGISTER (0x03h)**

Default value is 0x00h.

#### **TABLE 12. I2S Mode Control Register**

| Bit   | Name           | Value |    |    | Description   |
|-------|----------------|-------|----|----|---|
| B7    | RESERVED       |       | Х  |    | Unused  |
|       |                | В6    | B5 | B4 | Sets I2S word size in Right Justified Mode  |
|       |                | 0     | 0  | 0  | 16  |
|       |                | 0     | 0  | 1  | 18  |
|       | I2S_WRD_2 (B6) | 0     | 1  | 0  | 20  |
| B6:B4 | I2S_WRD_1 (B5) | 0     | 1  | 1  | 22  |
|       | I2S_WRD_0 (B5) | 1     | 0  | 0  | 24  |
|       |                | 1     | 0  | 1  | 25  |
|       |                | 1     | 1  | 0  | 26  |
|       |                | 1     | 1  | 1  | 32  |
| В3    | I2S_STEREO     |       | 0  |    | Normal mode. Left channel data goes to left channel output Right channel data goes to right channel output.   |
| ы     | _REVERSE       |       | 1  |    | Reverse mode.  Left channel data goes to right channel output  Right channel data goes to left channel output |

| Bit          | Name            |   | Value | Description  |
|--------------|-----------------|---|-------|--|
| l2S_WORD_ORD |                 | 0 |       | Normal mode.  I <sup>2</sup> S_WS = 0 indicates left channel audio I <sup>2</sup> S_WS = 1 indicates right channel audio   |
| B2           | ER              |   | 1     | Reverse mode.  I <sup>2</sup> S_WS = 0 indicates right channel audio I <sup>2</sup> S_WS = 1 indicates left channel audio. |
|              |                 |   | В0    | Sets I <sup>2</sup> S operating mode   |
|              | IOO MODE 4 (D4) | 0 | 0     | Normal Mode  |
| B1:B0        |                 | 0 | 1     | Left Justified Mode  |
|              |                 | 1 | 0     | Right Justified Mode   |
|              |                 | 1 | 1     | Unused   |

#### 12S CLOCK REGISTER (0x04h)

Default value is 0x00h.

TABLE 13. I2S Clock Register

| Bit    | Name              |    | Va    | lue |                                       | Descr   | ription                                   |  |
|--------|-------------------|----|-------|-----|---------------------------------------|---|---|--|
|        |                   | В7 | В6    | B5  | B4                                    | Sets divider ratio to derive the I2S<br>I2S master mode<br>DIVIDE BY  | S clock from the divided MCLK in          |  |
|        |                   | 0  | 0     | 0   | 0                                     | 1   | TIATIO                                    |  |
|        |                   | 0  | 0     | 0   | 1                                     | 2   |   |  |
|        |                   | 0  | 0     | 1   | 0                                     | 4   | _   |  |
|        | 12S_CLK_3         | 0  | 1     | 1   | 1                                     | 6   | _   |  |
|        | (B7)              | 0  | 0     | 0   | 0                                     | 8   | _   |  |
|        | 12S_CLK_2         | 0  | 0     | 1   | 1                                     | 10  | _   |  |
| B7:B4  | (B6)              | 0  | 1     | 0   | 0                                     | 16  | _   |  |
|        | I2S_CLK_1<br>(B5) | 0  | 1     | 1   | 1                                     | 20  | _   |  |
|        | 12S_CLK_0         | 1  | 0     | 0   | 0                                     | 2.5   | 2.5                                       |  |
|        | (B4)              | 1  | 0     | 0   | 1                                     | 3   | 1:3                                       |  |
|        |                   | 1  | 0     | 1   | 0                                     | 3.90625   | 32:125                                    |  |
|        |                   | 1  | 0     | 1   | 1                                     | 5   | 1:5                                       |  |
|        |                   | 1  | 1     | 0   | 0                                     | 7.8125  | 16:125                                    |  |
|        |                   | 1  | 1     | 0   | 1                                     | _   | _   |  |
|        |                   | 1  | 1     | 1   | 0                                     | _   | _   |  |
|        |                   | 1  | 1     | 1   | 1                                     | _   | _   |  |
|        | I2S_WS_1          | Е  | B3 B2 |     | Determines the bit length per da mode | ta word of I2S_WS in I2S master   |   |  |
| DO: DO | (B3)              | (  | 0     | 0   |                                       | 16  |   |  |
| B3:B2  | 12S_WS_0          | (  | 0     | 1   |                                       | 25  |   |  |
|        | (B2)              |    | 1 0   |     | 0                                     | 32  |   |  |
|        |                   |    | 1     | 1   |                                       | _   |   |  |
|        |                   | 0  |       |     |                                       | I <sup>2</sup> S WS slave mode. The LM49450 drives the I <sup>2</sup> S WS signal from                                |   |  |
| B1     | I2S_WS_M          |    |       |     |                                       | the I2S_WS line.  |   |  |
|        | S                 |    |       | 1   |                                       | 12S WS master mode. The LM494 12S_WS line is driven by the LM4  | 450 generates the I2S WS signal.<br>49450 |  |
| D0     | I2S_CLK_          | 0  |       |     |                                       | I <sup>2</sup> S clock slave mode. The LM49450 derives its I <sup>2</sup> S clock from the I <sup>2</sup> S_CLK line. |   |  |
| B0     | MS                |    |       | İ   |                                       | I <sup>2</sup> S clock master mode. The LM <sup>2</sup> signal. I2S_CLK line is driven by                             | _   |  |

#### **HEADPHONE 3D CONFIGURATION REGISTER (0x05h)**

Default value is 0x00h.

**TABLE 14. Headphone 3D Configuration Register** 

| Bit    | Name                                 | Value |    | Description  |
|--------|--------------------------------------|-------|----|--|
| B7     | RESERVED                             | X     |    | UNUSED   |
| B6     | HP_3DATTN                            | 0     |    | No Attenuation   |
| Во     | HF_SDATTN                            | 1     |    | Output signals are attenuated by 6dB                     |
|        |                                      | B5    | B4 | Sets 3D high pass filter -3dB (roll-off) frequency       |
|        | LID ODEDEO 4 (DE)                    | 0     | 0  | 0  |
| B5:B4  | HP_3DFREQ_1 (B5)<br>HP_3DFREQ_0 (B4) | 0     | 1  | 300Hz  |
|        | HP_3DFREQ_0 (B4)                     | 1     | 0  | 600Hz  |
|        |                                      | 1 1   |    | 900Hz  |
|        |                                      | В3    | B2 | Sets the 3D mix level, ie the amount of the left channel |
|        | HP_3DFREQ_1 (B3)<br>HP_3DFREQ_0 (B2) |       |    | signal that appears on the right channel and visa versa. |
| DO: DO |                                      | 0     | 0  | 25%  |
| B3:B2  |                                      | 0     | 1  | 37.5%  |
|        |                                      | 1     | 0  | 50%  |
|        |                                      | 1 1   |    | 75%  |
| B1     | HD 3D                                | 0     |    | Narrow 3D effect   |
| В      | HP_3D                                | 1     |    | Wide 3D effect   |
| BO     | HD 2DEN                              | 0     |    | Headphone 3D disabled                                    |
| B0     | HP_3DEN                              | 1     |    | Headphone 3D enabled                                     |

## LOUDSPEAKER 3D CONFIGURATION REGISTER (0x06h)

Default value is 0x00h.

**TABLE 15. Loudspeaker 3D Configuration Register** 

| Bit   | Name                                 | Value |    | Description   |  |
|-------|--------------------------------------|-------|----|---|--|
| B7    | RESERVED                             | X     |    | UNUSED  |  |
| B6    | I C 2DATTN                           | 0     |    | No Attenuation  |  |
| D0    | LS_3DATTN                            | 1     |    | Output signals are attenuated by 6dB  |  |
|       |                                      | B5    | B4 | Sets 3D high pass filter -3dB (roll-off) frequency  |  |
|       | 1.0 0DEDEO 4 (DE)                    | 0     | 0  | 0   |  |
| B5:B4 | LS_3DFREQ_1 (B5)<br>LS_3DFREQ_0 (B4) | 0     | 1  | 300Hz   |  |
|       | L3_3DFNEQ_0 (B4)                     | 1     | 0  | 600Hz   |  |
|       |                                      | 1 1   |    | 900Hz   |  |
|       |                                      | В3    | B2 | Sets the 3D mix level, ie the amount of the left channel signal that appears on the right channel and visa versa. |  |
| Do Do | LS_3DFREQ_1 (B3)<br>LS_3DFREQ_0 (B2) | 0     | 0  | 25%   |  |
| B3:B2 |                                      | 0     | 1  | 37.5%   |  |
|       |                                      | 1     | 0  | 50%   |  |
|       |                                      | 1     | 0  | 75%   |  |
| B1    | HD 2D                                | 0     |    | Narrow 3D effect  |  |
| БІ    | HP_3D                                | 1     |    | Wide 3D effect  |  |
| В0    | HD 2DEN                              | 0     |    | Loudspeaker 3D disabled   |  |
| BU    | HP_3DEN                              | 1     |    | Loudspeaker 3D enabled  |  |

#### **HEADPHONE VOLUME CONTROL REGISTER (0x07h)**

Default value is 0x00h.

**TABLE 16. Headphone Volume Control Register** 

| Bit   | Name   | Value                                 | Description  |
|-------|--|---------------------------------------|--|
| B7:B5 | RESERVED   | X                                     | UNUSED   |
| B4:B0 | HP4 (B4)<br>HP3 (B3)<br>HP2 (B2)<br>HP1 (B1)<br>HP0 (B0) | See Headphone Volume<br>Control Table | Controls gain/attenuation of the audio signal in the headphone path. |

| VOLUME<br>STEP | HP4 | HP3 | HP2 | HP1 | HP0 | HP GAIN (dB) |
|----------------|-----|-----|-----|-----|-----|--------------|
| 1              | 0   | 0   | 0   | 0   | 0   | <b>–</b> 59  |
| 2              | 0   | 0   | 0   | 0   | 1   | -48          |
| 3              | 0   | 0   | 0   | 1   | 0   | -40.5        |
| 4              | 0   | 0   | 0   | 1   | 1   | -34.5        |
| 5              | 0   | 0   | 1   | 0   | 0   | -30          |
| 6              | 0   | 0   | 1   | 0   | 1   | -27          |
| 7              | 0   | 0   | 1   | 1   | 0   | -24          |
| 8              | 0   | 0   | 1   | 1   | 1   | -21          |
| 9              | 0   | 1   | 0   | 0   | 0   | -18          |
| 10             | 0   | 1   | 0   | 0   | 1   | <b>–15</b>   |
| 11             | 0   | 1   | 0   | 1   | 0   | -13.5        |
| 12             | 0   | 1   | 0   | 1   | 1   | -12          |
| 13             | 0   | 1   | 1   | 0   | 0   | -10.5        |
| 14             | 0   | 1   | 1   | 0   | 1   | <b>-9</b>    |
| 15             | 0   | 1   | 1   | 1   | 0   | -7.5         |
| 16             | 0   | 1   | 1   | 1   | 1   | -6           |
| 17             | 1   | 0   | 0   | 0   | 0   | -4.5         |
| 18             | 1   | 0   | 0   | 0   | 1   | -3           |
| 19             | 1   | 0   | 0   | 1   | 0   | -1.5         |
| 20             | 1   | 0   | 0   | 1   | 1   | 0            |
| 21             | 1   | 0   | 1   | 0   | 0   | 1.5          |
| 22             | 1   | 0   | 1   | 0   | 1   | 3            |
| 23             | 1   | 0   | 1   | 1   | 0   | 4.5          |
| 24             | 1   | 0   | 1   | 1   | 1   | 6            |
| 25             | 1   | 1   | 0   | 0   | 0   | 7.5          |
| 26             | 1   | 1   | 0   | 0   | 1   | 9            |
| 27             | 1   | 1   | 0   | 1   | 0   | 10.5         |
| 28             | 1   | 1   | 0   | 1   | 1   | 12           |
| 29             | 1   | 1   | 1   | 0   | 0   | 13.5         |
| 30             | 1   | 1   | 1   | 0   | 1   | 15           |
| 31             | 1   | 1   | 1   | 1   | 0   | 16.5         |
| 32             | 1   | 1   | 1   | 1   | 1   | 18           |

#### LOUDSPEAKER VOLUME CONTROL REGISTER (0x08h)

Default value is 0x00h.

**TABLE 17. Loudspeaker Volume Control Register** 

| Bit   | Name   | Value                                   | Description  |
|-------|--|---|--|
| B7:B5 | RESERVED   | X                                       | UNUSED   |
| B4:B0 | LS4 (B4)<br>LS3 (B3)<br>LS2 (B2)<br>LS1 (B1)<br>LS0 (B0) | See Loudspeaker Volume<br>Control Table | Controls gain/attenuation of the audio signal in the loudspeaker path. |

| VOLUME<br>STEP | LS4 | LS3 | LS2 | LS1 | LS0 | LS GAIN (dB) |
|----------------|-----|-----|-----|-----|-----|--------------|
| 1              | 0   | 0   | 0   | 0   | 0   | -53          |
| 2              | 0   | 0   | 0   | 0   | 1   | -42          |
| 3              | 0   | 0   | 0   | 1   | 0   | -34.5        |
| 4              | 0   | 0   | 0   | 1   | 1   | -28.5        |
| 5              | 0   | 0   | 1   | 0   | 0   | -24          |
| 6              | 0   | 0   | 1   | 0   | 1   | -21          |
| 7              | 0   | 0   | 1   | 1   | 0   | -18          |
| 8              | 0   | 0   | 1   | 1   | 1   | <b>–15</b>   |
| 9              | 0   | 1   | 0   | 0   | 0   | -12          |
| 10             | 0   | 1   | 0   | 0   | 1   | -9           |
| 11             | 0   | 1   | 0   | 1   | 0   | -7.5         |
| 12             | 0   | 1   | 0   | 1   | 1   | -6           |
| 13             | 0   | 1   | 1   | 0   | 0   | -4.5         |
| 14             | 0   | 1   | 1   | 0   | 1   | -3           |
| 15             | 0   | 1   | 1   | 1   | 0   | -1.5         |
| 16             | 0   | 1   | 1   | 1   | 1   | 0            |
| 17             | 1   | 0   | 0   | 0   | 0   | 1.5          |
| 18             | 1   | 0   | 0   | 0   | 1   | 3            |
| 19             | 1   | 0   | 0   | 1   | 0   | 4.5          |
| 20             | 1   | 0   | 0   | 1   | 1   | 6            |
| 21             | 1   | 0   | 1   | 0   | 0   | 7.5          |
| 22             | 1   | 0   | 1   | 0   | 1   | 9            |
| 23             | 1   | 0   | 1   | 1   | 0   | 10.5         |
| 24             | 1   | 0   | 1   | 1   | 1   | 12           |
| 25             | 1   | 1   | 0   | 0   | 0   | 13.5         |
| 26             | 1   | 1   | 0   | 0   | 1   | 15           |
| 27             | 1   | 1   | 0   | 1   | 0   | 16.5         |
| 28             | 1   | 1   | 0   | 1   | 1   | 18           |
| 29             | 1   | 1   | 1   | 0   | 0   | 19.5         |
| 30             | 1   | 1   | 1   | 0   | 1   | 21           |
| 31             | 1   | 1   | 1   | 1   | 0   | 22.5         |
| 32             | 1   | 1   | 1   | 1   | 1   | 24           |

## DAC COMPENSATION FILTER REGISTERS (0x09h to 0x0Eh)

#### **DAC Compensation Filter**

The LM49450 DAC features a 5 band FIR filter that can be used as an equalizer for the digital audio path. Registers 0x09h, 0x0Ah, 0x0Bh, 0x0Ch, 0x0Dh, and 0x0Eh provide an 8-bit control for each individual FIR filter.

#### **EXTERNAL COMPONENT SELECTION**

The LM49450 uses different supplies for each portion of the device, allowing for the optimum combination of headroom, power dissipation and noise immunity. The speaker amplifier gain stage is powered from  $V_{\rm DD}$ , while the output stage is powered from LSV $_{\rm DD}$ . The headphone amplifiers, input amplifiers and volume control stages are powered from HPV $_{\rm DD}$ . The separate power supplies allow the speakers to operate from a higher voltage for maximum headroom, while the headphones operate from a lower voltage, improving power dissipation. HPV $_{\rm DD}$  may be driven by a linear regulator to further improve performance in noisy environments. The  $^{\rm 12}C$  portion if powered from  $^{\rm 12}CV_{\rm DD}$ , allowing the  $^{\rm 12}C$  portion of the LM49450 to interface with lower voltage digital controllers.

#### PROPER SELECTION OF EXTERNAL COMPONENTS

#### **Power Supply Bypassing and Filtering**

Proper power supply bypassing is critical for low noise performance and high PSRR. Place the supply bypass capacitors as close to the device as possible. Typical applications employ a voltage regulator with  $10\mu F$  and  $0.1\mu F$  bypass capacitors that increase supply stability. These capacitors do not eliminate the need for bypassing of the LM49450 supply pins. A  $1\mu F$  ceramic capacitor placed close to each supply pin is recommended.

#### **Bypass Capacitor Selection**

The LM49450 internally generates a  $V_{DD}/2$  common-mode bias voltage. The BYPASS capacitor CBYPASS, improves PSRR and THD+N by reducing noise at the BYPASS node. Use a 2.2 $\mu$ F ceramic placed as close to the device as possible.

#### **REF Capacitor Selection**

The LM49450 generates an internal low noise reference voltage used by the DAC. For best THD+N performance, bypass REF with 10µF and 0.1µF ceramic capacitors.

#### **Charge Pump Capacitor Selection**

Use low ESR ceramic capacitors (less than  $100m\Omega$ ) for optimum performance.

#### **Charge Pump Flying Capacitor (C1)**

The flying capacitor (C1) affects the load regulation and output impedance of the charge pump. A C1 value that is too low results in a loss of current drive, leading to a loss of amplifier headroom. A higher valued C1 improves load regulation and lowers charge pump output impedance to an extent. Above 2.2 $\mu$ F, the R<sub>DS(ON)</sub> of the charge pump switches and the ESR of C1 and C2 dominate the output impedance. A lower value capacitor can be used in systems where low maximum output power requirements.

#### **Charge Pump Hold Capacitor (C2)**

The value and ESR of the hold capacitor (C2) directly affects the ripple on  $\text{CPV}_{\text{SS}}$ . Increasing the value of C2 reduces output ripple. Decreasing the ESR of C2 reduces both output ripple and charge pump output impedance. A lower value capacitor can be used in systems where low maximum output power requirements.

#### **Input Capacitor Selection**

The LM49450 analog inputs require input coupling capacitors. Input capacitors block the DC component of the audio signal, eliminating any conflict between the DC component of the audio source and the bias voltage of the LM49450. The input capacitors create a high-pass filter with the input resistors  $\rm R_{\rm IN}$ . The -3dB point of the high pass filter is found using Equation (1) below.

$$f = 1 / 2\pi R_{IN} C_{IN}$$
 (1)

Where the value of  $R_{IN}$  is typically  $20k\Omega$ .

The input capacitors can also be used to remove low frequency content from the audio signal. Small speakers cannot reproduce, and may even be damaged by low frequencies. High pass filtering the audio signal helps protect the speakers. When the LM49450 is using a single-ended source, power supply noise on the ground is seen as an input signal. Setting the high-pass filter point above the power supply noise frequencies, 217Hz in a GSM phone, for example, filters out the noise such that it is not amplified and heard on the output. Capacitors with a tolerance of 10% or better are recommended for impedance matching and improved CMRR and PSRR.

#### **PCB Layout Guidelines**

Minimize trace impedance of the power, ground and all output traces for optimum performance. Voltage loss due to trace resistance between the LM49450 and the load results in decreased output power and efficiency. Trace resistance between the power supply and ground has the same effect as a poorly regulated supply, increased ripple and reduced peak output power. Use wide traces for power supply inputs and amplifier outputs to minimize losses due to trace resistance, as well as route heat away from the device. Proper grounding improves audio performance, minimizes crosstalk between channels and prevents switching noise from interfering with the audio signal. Use of power and ground planes is recommended.

Place all digital components and route digital signal traces as far as possible from analog components and traces. Do not run digital and analog traces in parallel on the same PCB layer. If digital and analog signal lines must cross either over or under each other, ensure that they cross in a perpendicular fashion

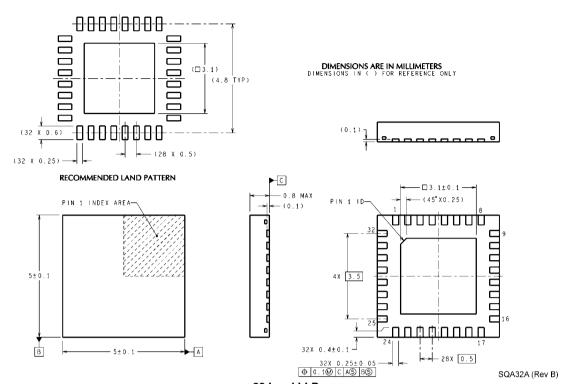
## **Exposed DAP Mounting Considerations**

The LM49450 LLP package features an exposed die-attach (thermal) pad on its backside. The exposed pad provides a direct heat conduction path from the die to the PCB, reducing the thermal resistance of the package. Connect the exposed pad to GND with a large pad and via to a large GND plane on the bottom of the PCB for best heat distribution.

## **Revision Table**

| Rev  | Date     | Description  |  |  |
|------|----------|--|--|--|
| 1.0  | 12/18/07 | Initial release.   |  |  |
| 1.01 | 09/26/08 | Corrected the package drawing.                               |  |  |
| 1.02 | 08/04/11 | On Table 5 (Common DAC Clock, col DAC MODE = 2b01 sample 8), |  |  |
| 1.02 | 00/04/11 | changed 2.084 to 2.048.                                      |  |  |

### Physical Dimensions inches (millimeters) unless otherwise noted



32 Lead LLP Order Number LM49450SQ NS Package Number SQA32A

#### **Notes**

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| PowerWise® Solutions                                | www.national.com/powerwise   | Applications & Markets          | www.national.com/solutions     |  |
| Serial Digital Interface (SDI) www.national.com/sdi |                              | Mil/Aero                        | www.national.com/milaero       |  |
| Temperature Sensors                                 | www.national.com/tempsensors | SolarMagic™                     | www.national.com/solarmagic    |  |
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